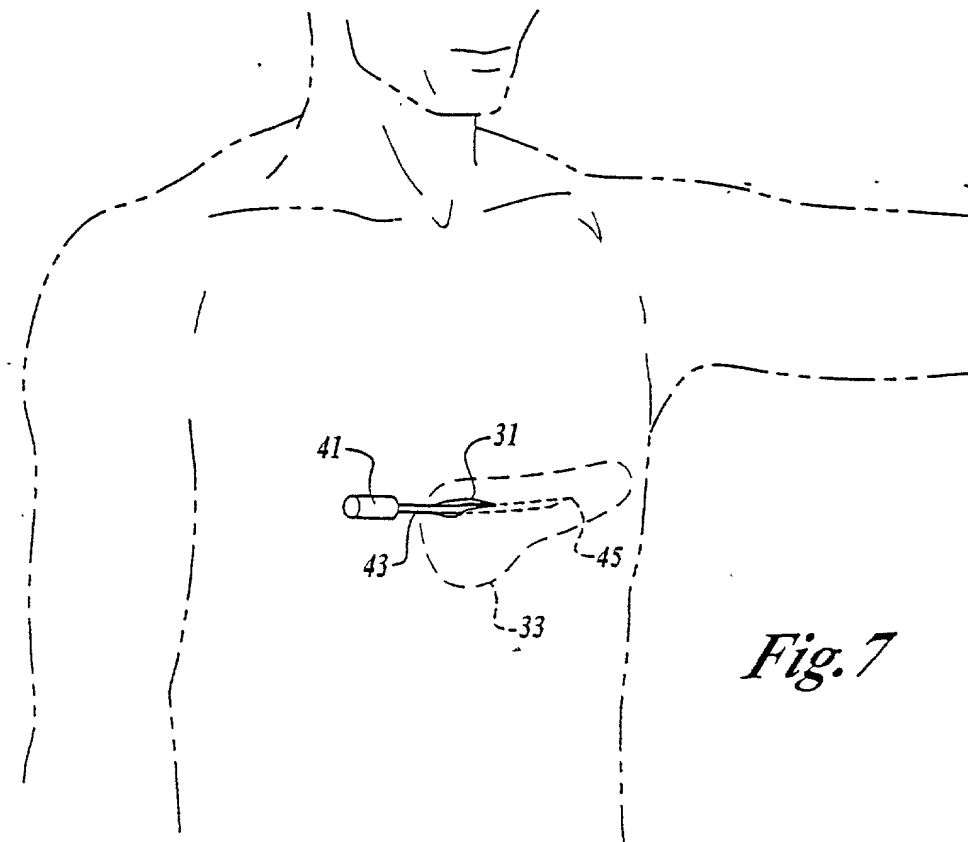
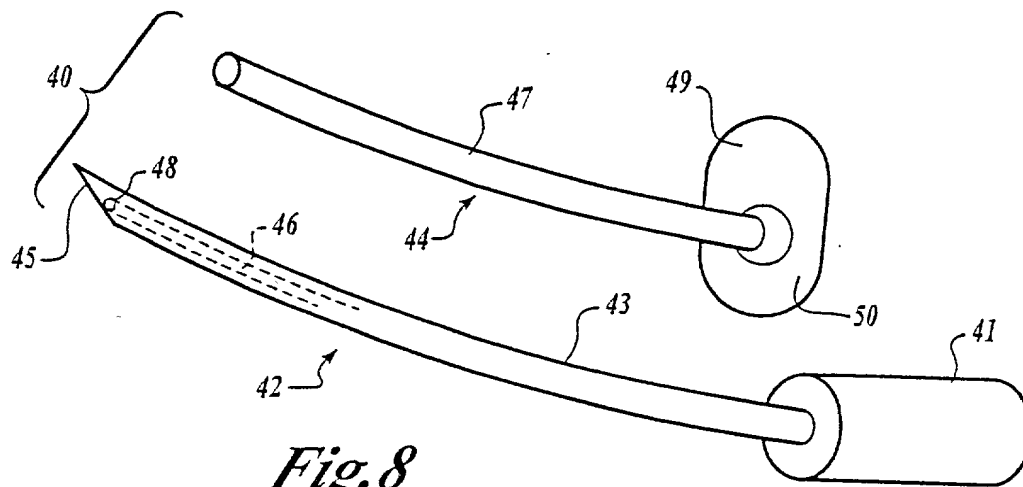


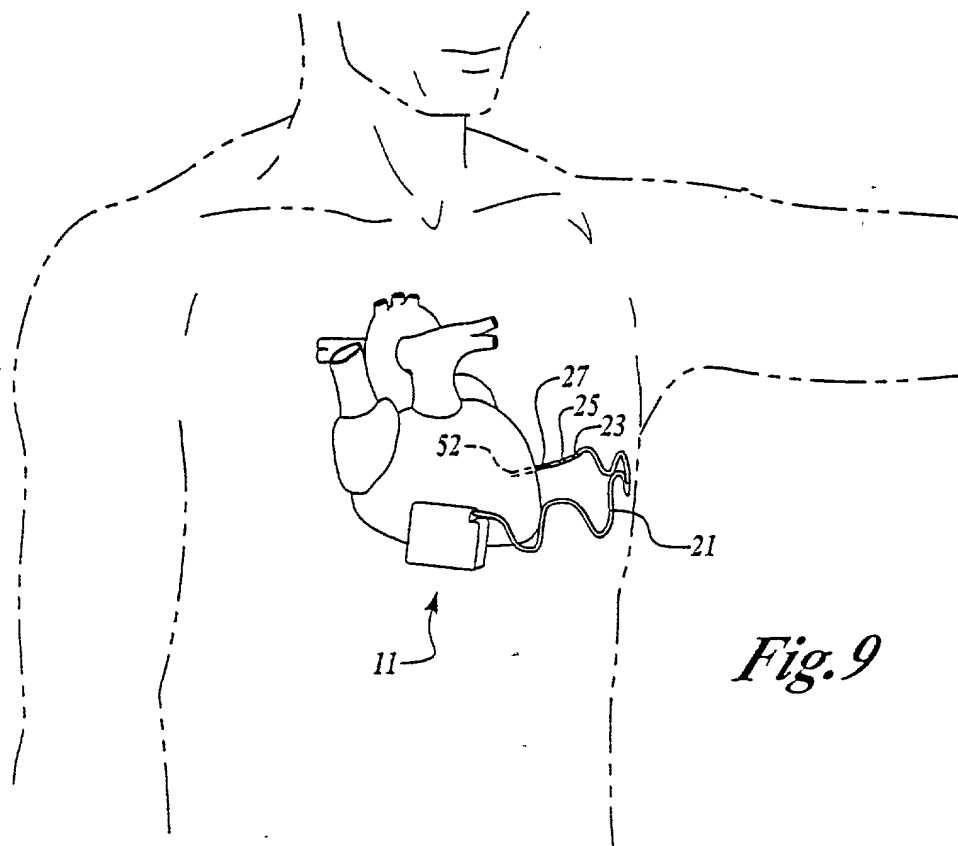
*Fig. 6*



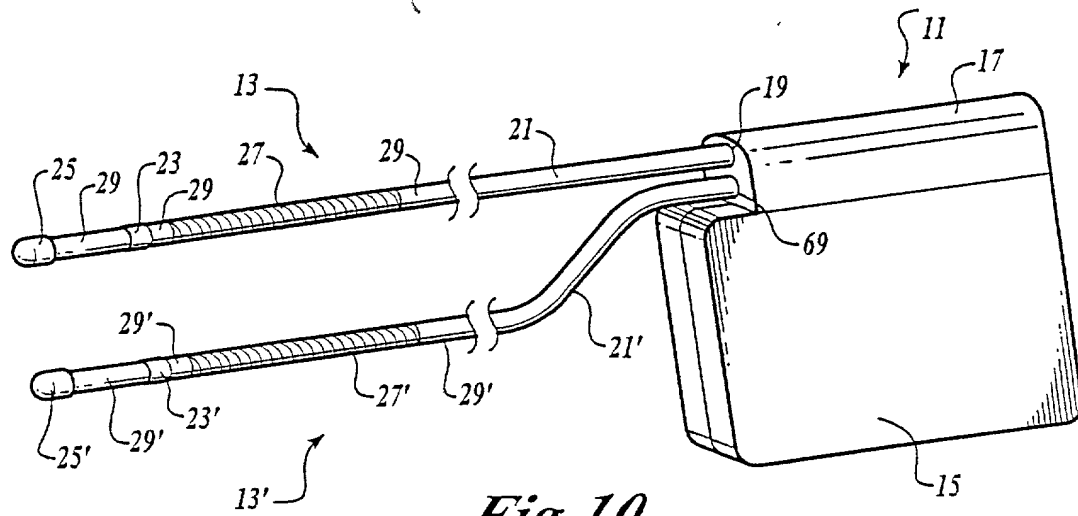
*Fig. 7*



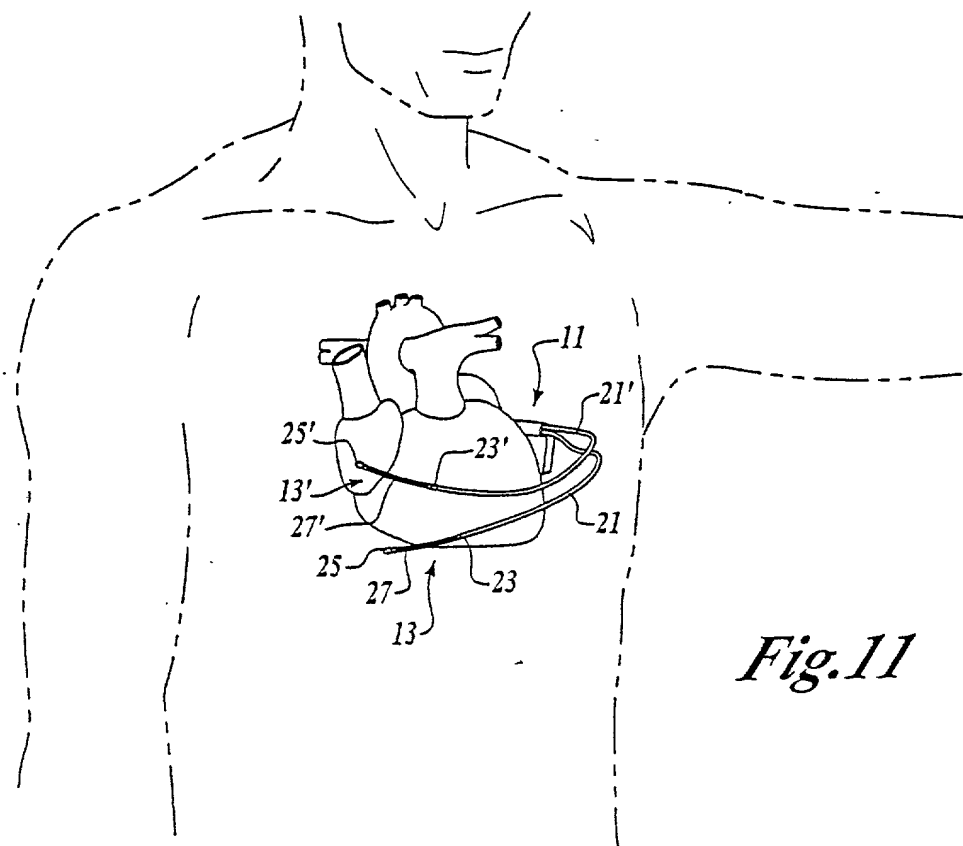
*Fig. 8*



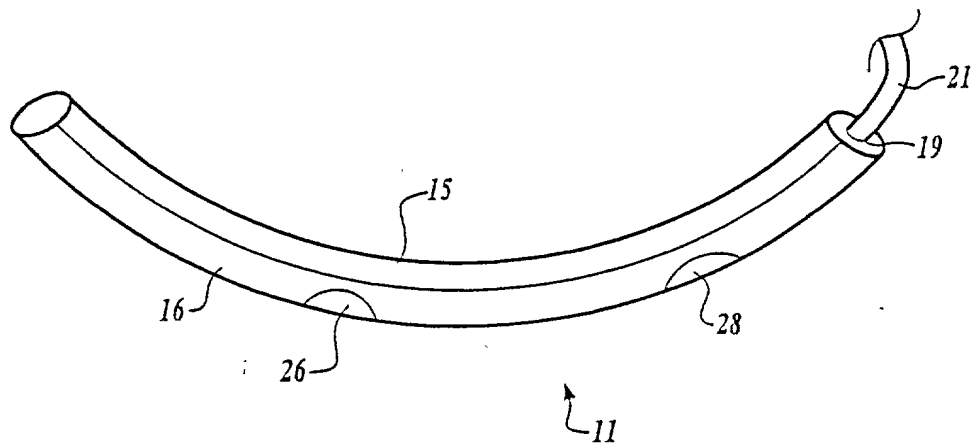
*Fig. 9*



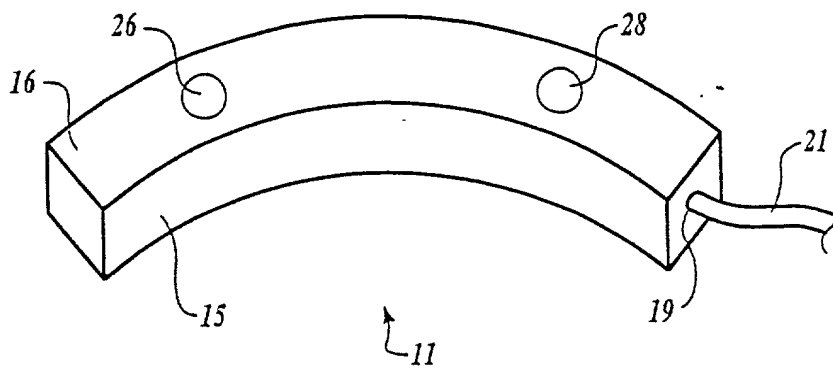
*Fig. 10*



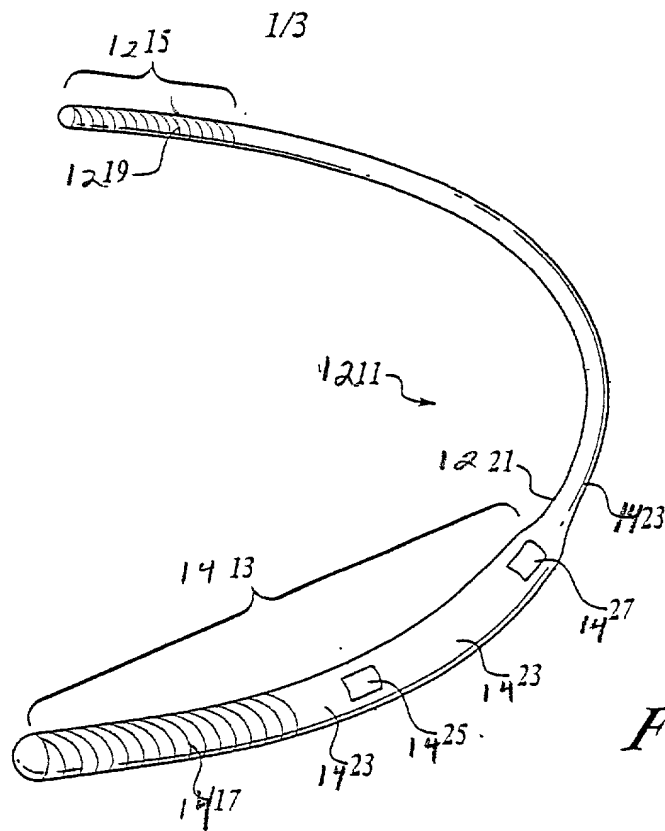
*Fig. 11*



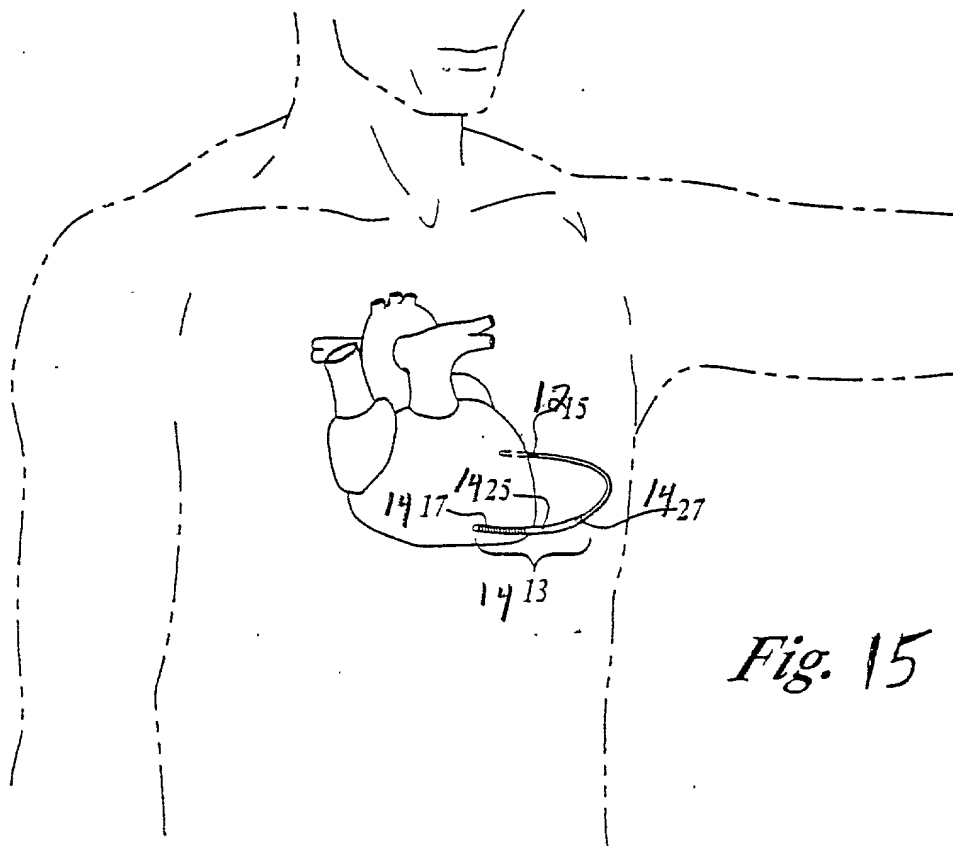
*Fig. 12*



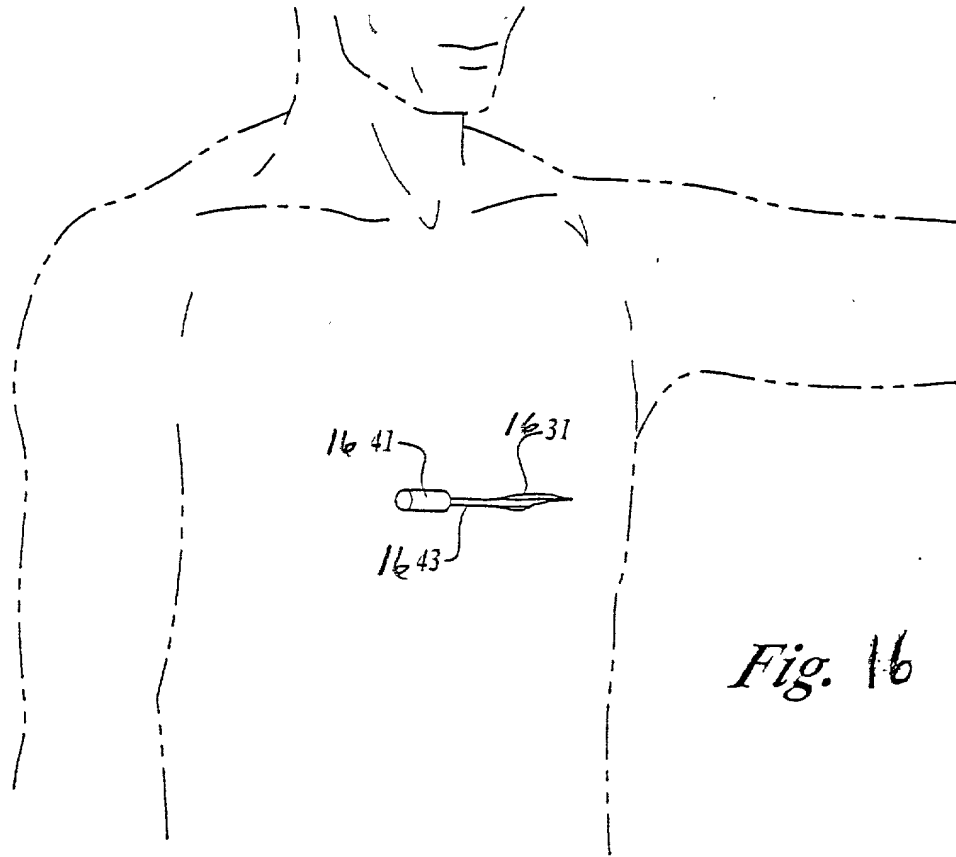
*Fig. 13*



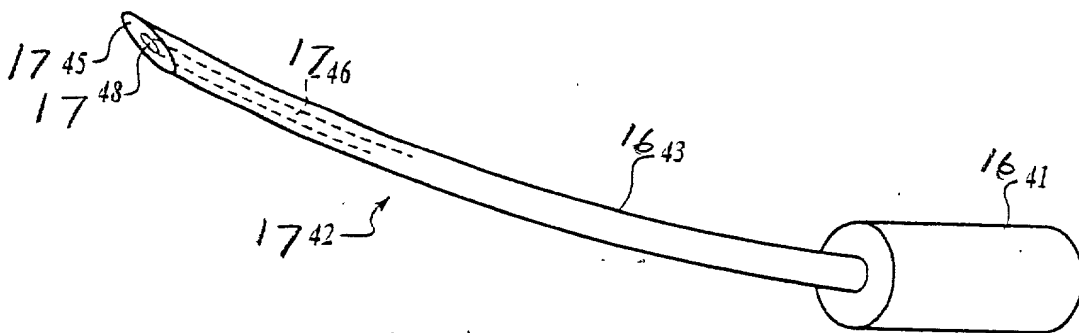
*Fig. 14*



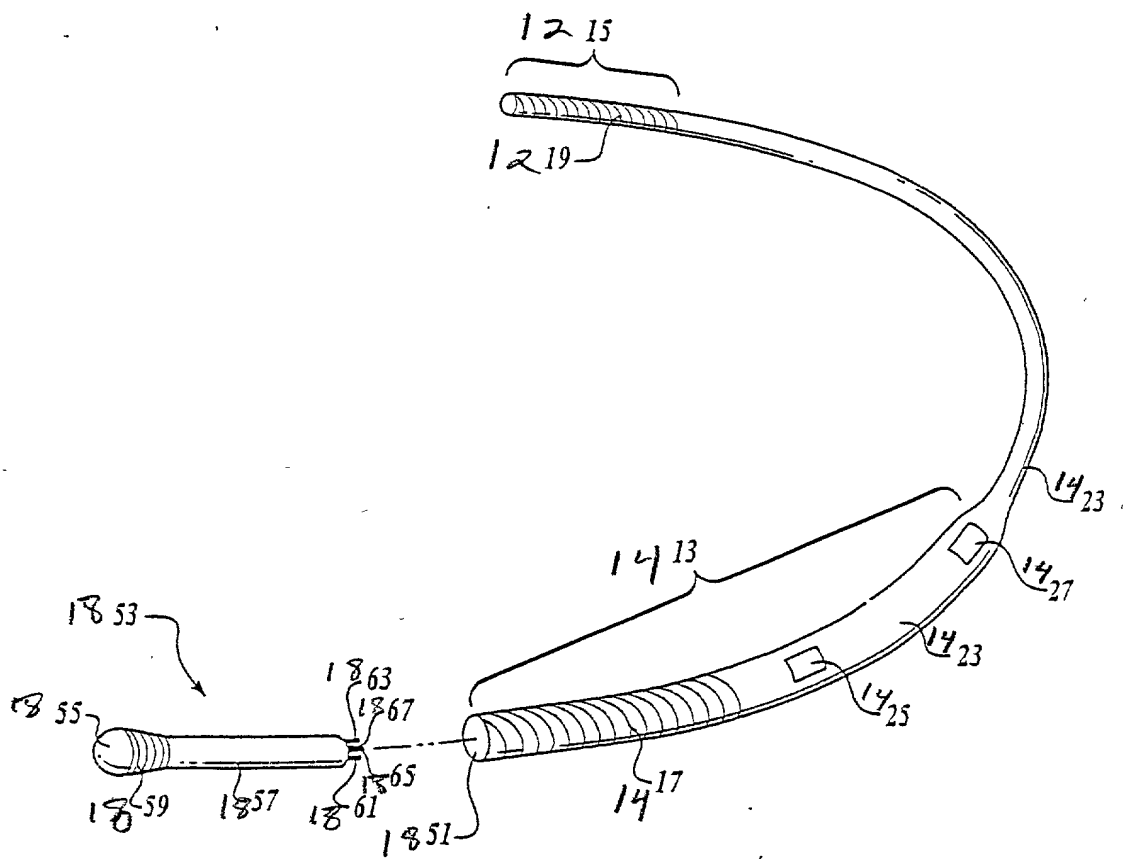
*Fig. 15*



*Fig. 16*



*Fig. 17*



*Fig. 18*

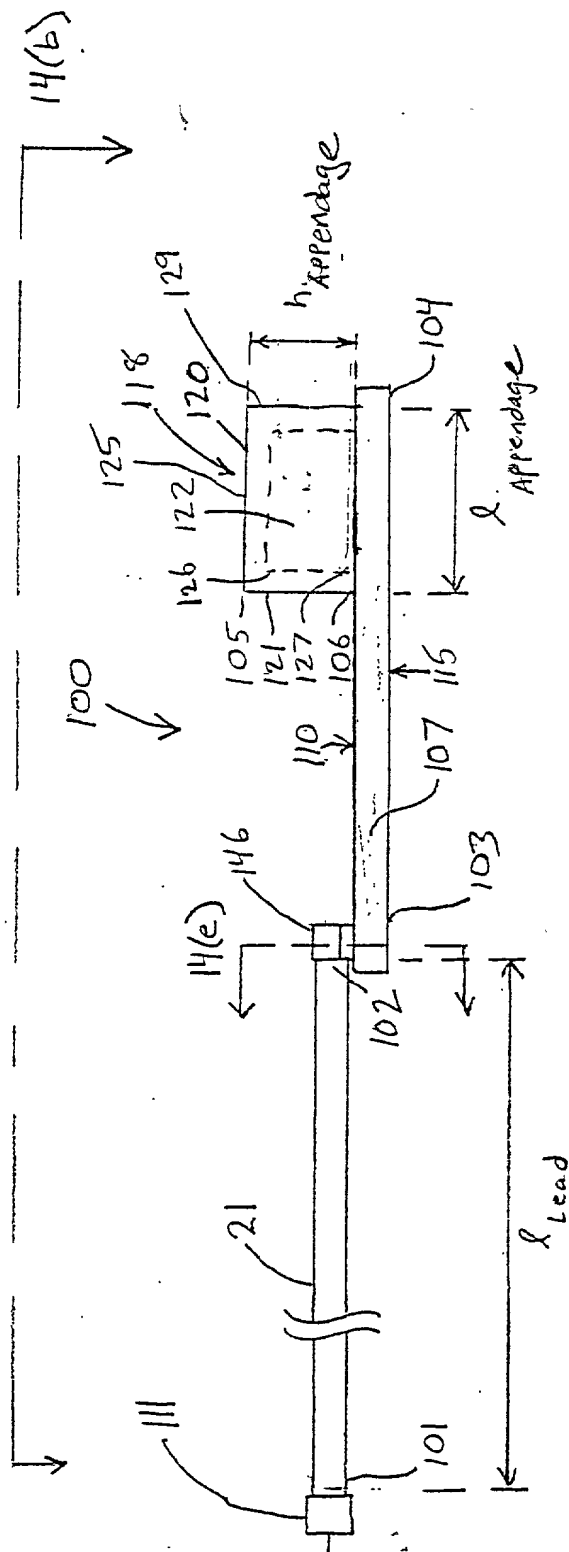


Fig. 14(a)

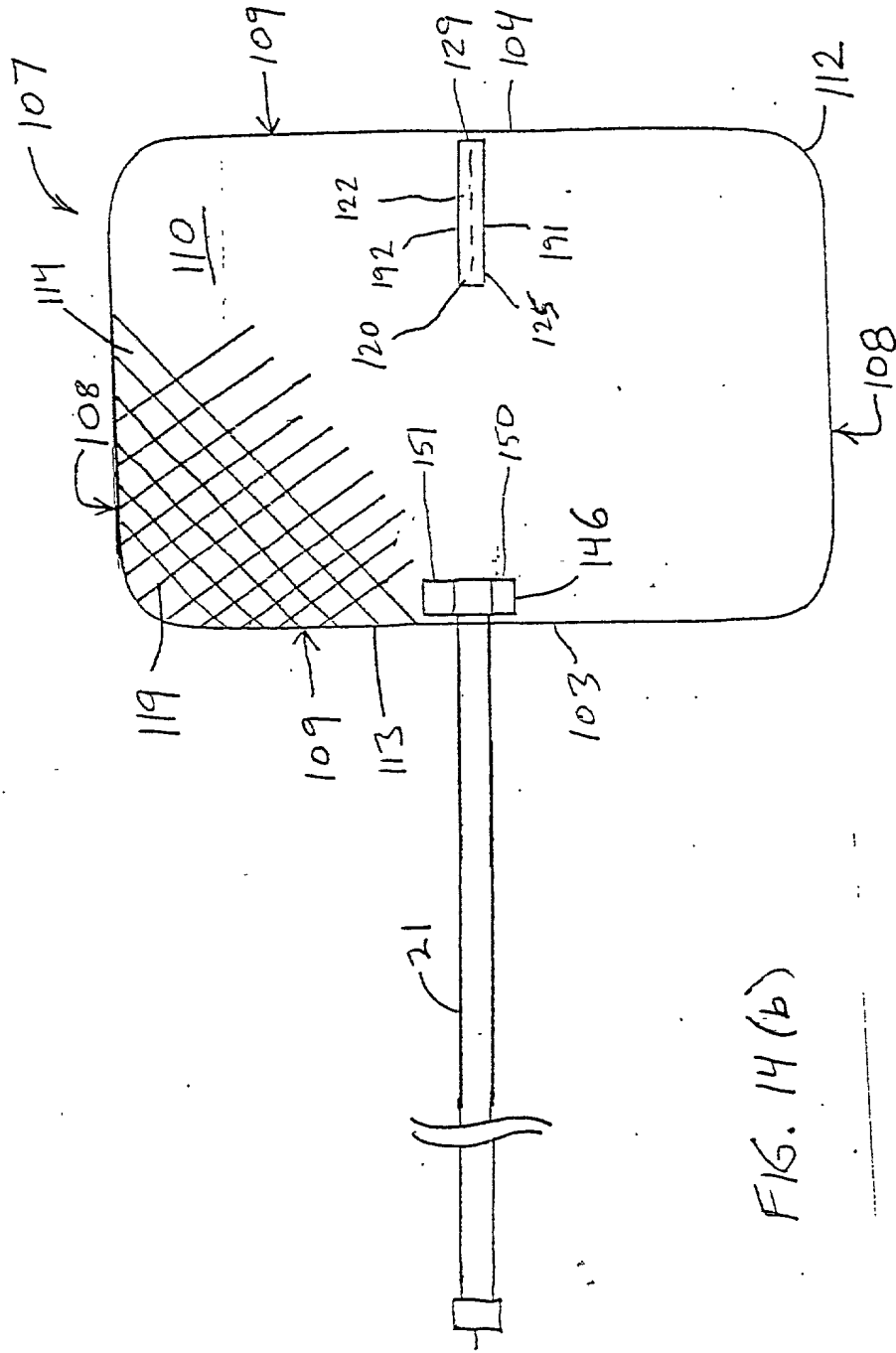


FIG. 14(b)

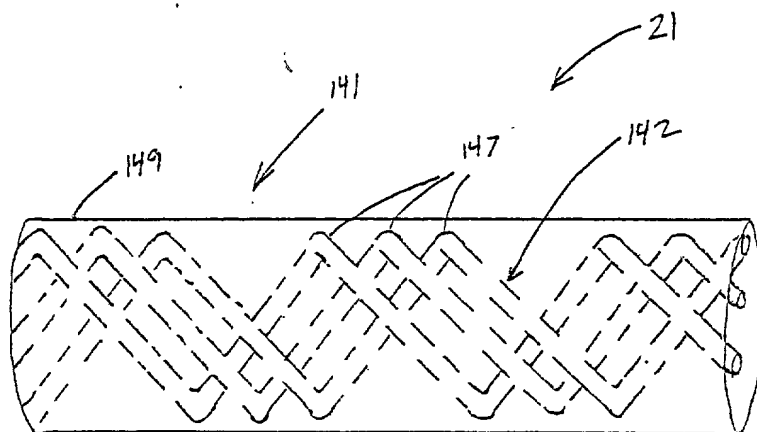


Fig.14(c)

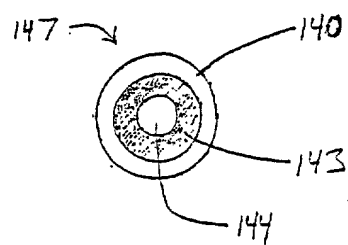


Fig.14(d)

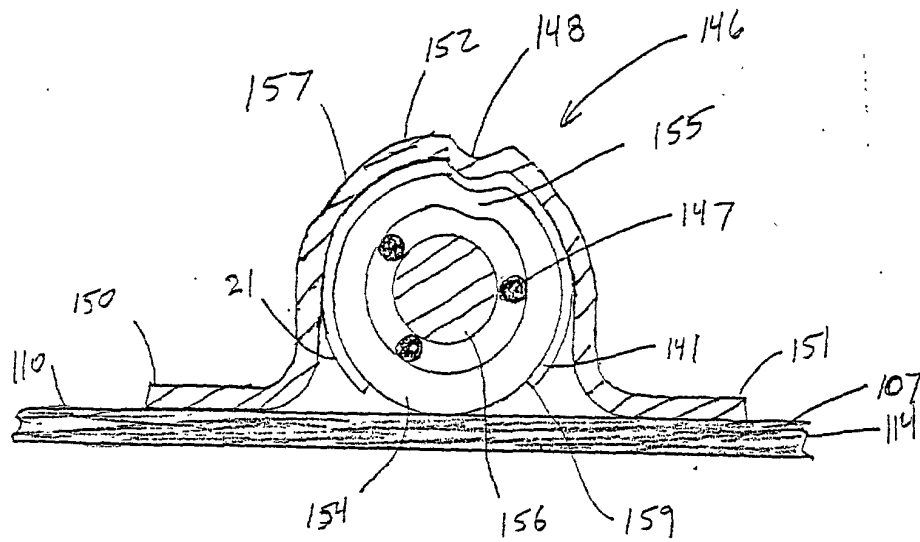
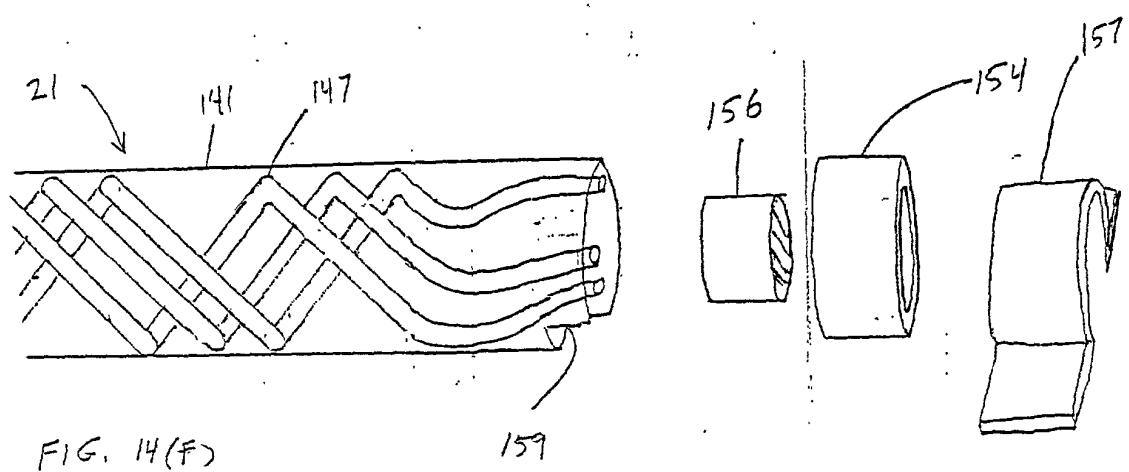
[illegible]

FIG. 14 (c)



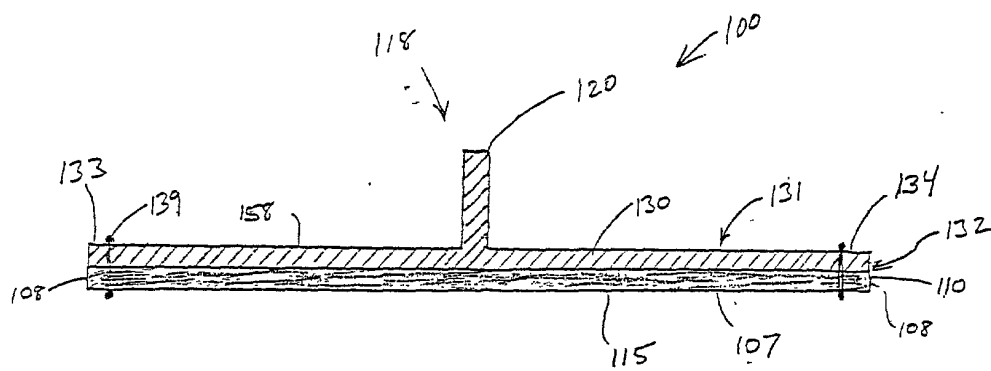


Fig.15(a)

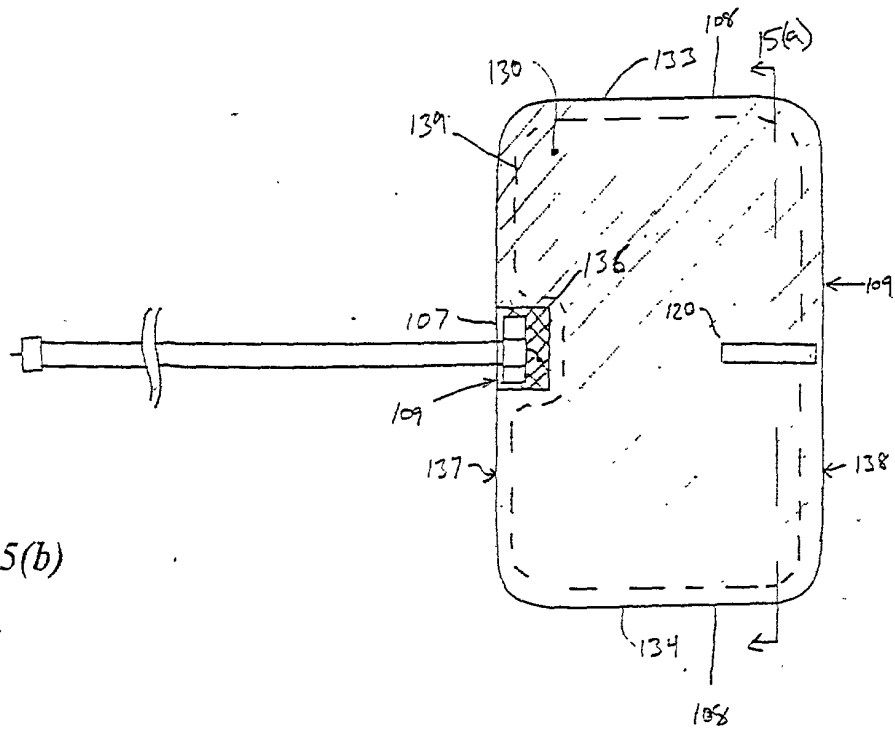


Fig.15(b)

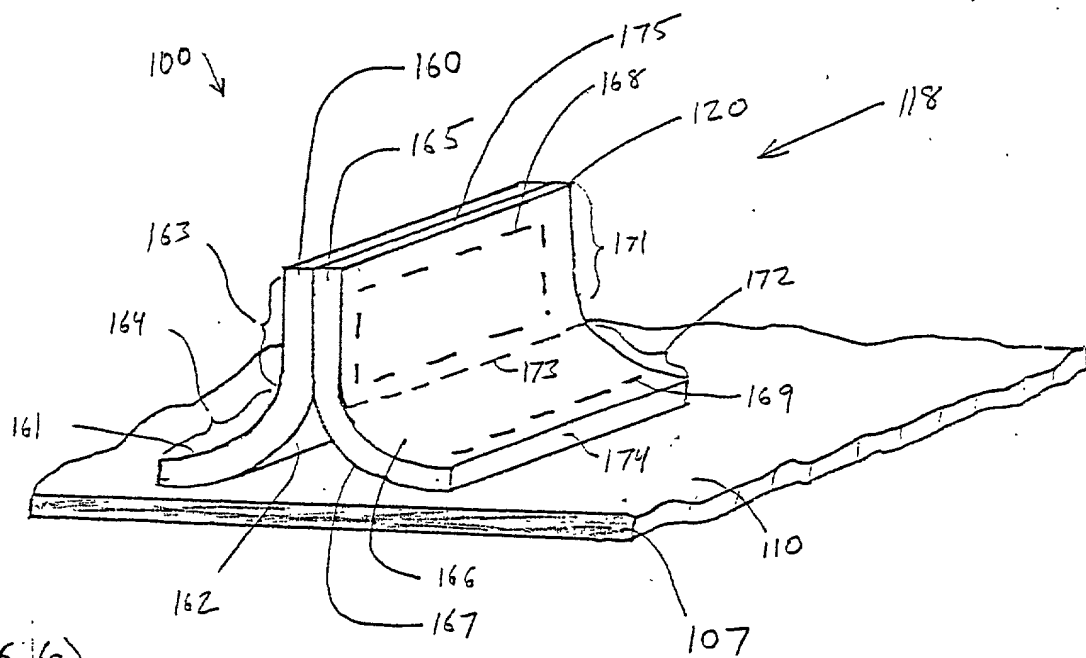


Fig.16 (a)

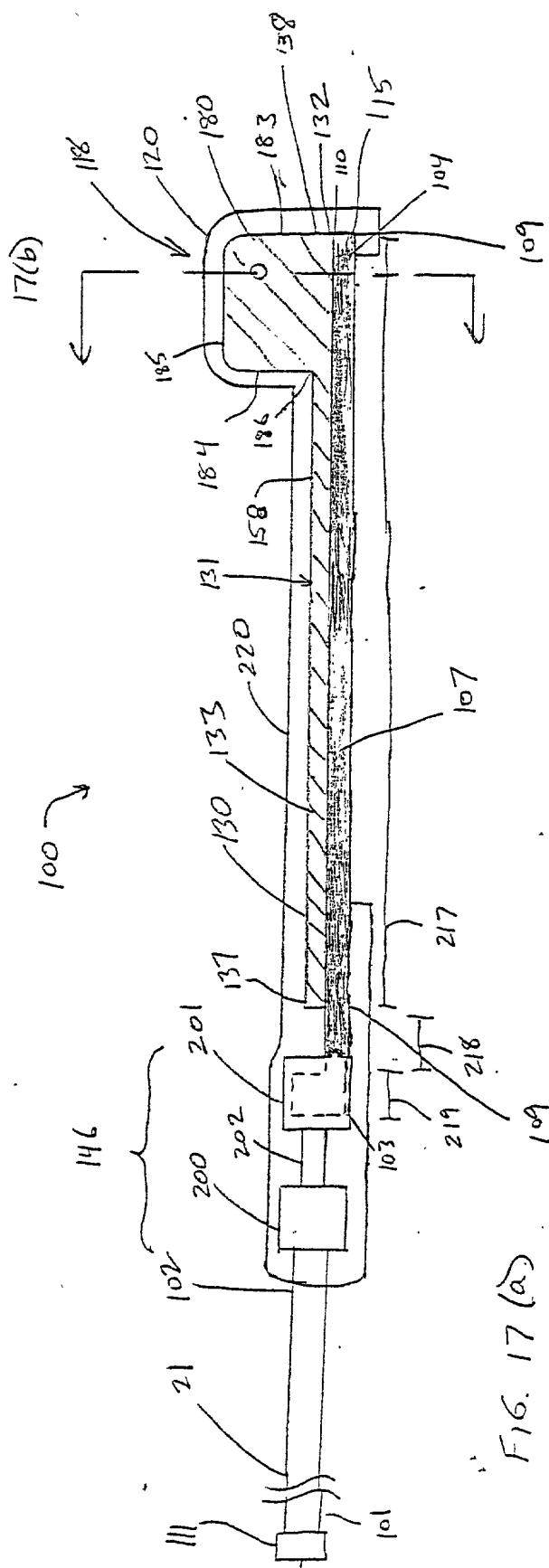


Fig. 17 (a)

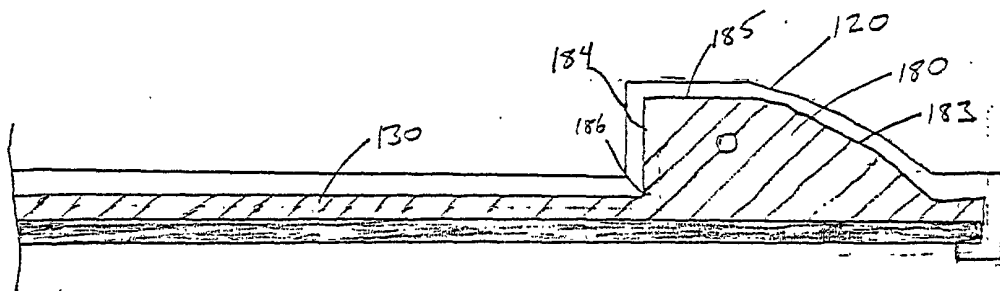


FIG. 17(b)

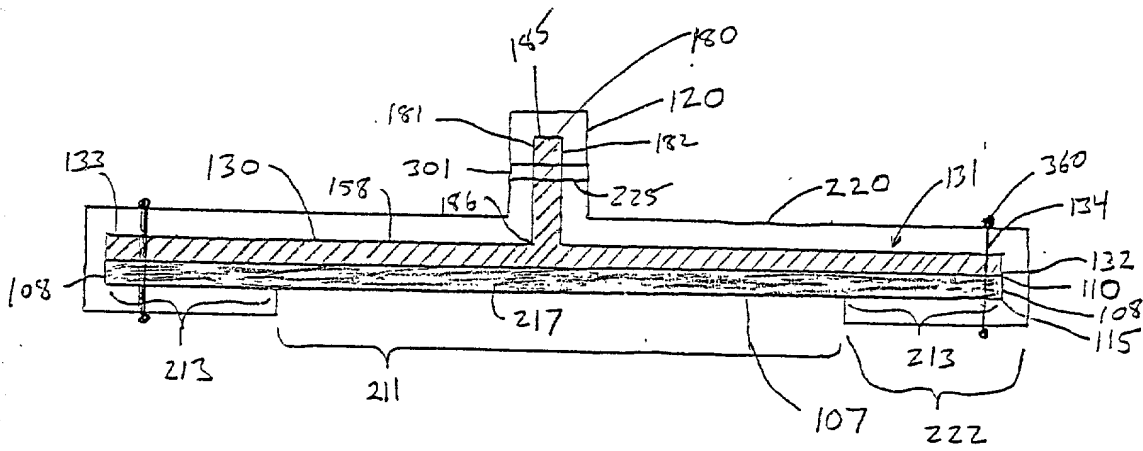
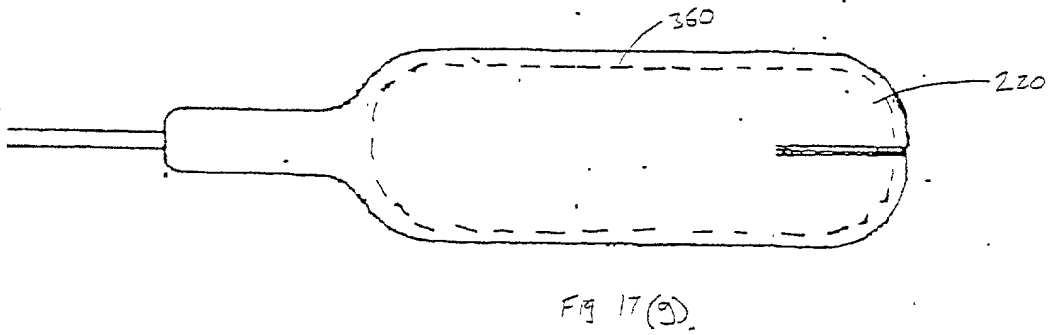
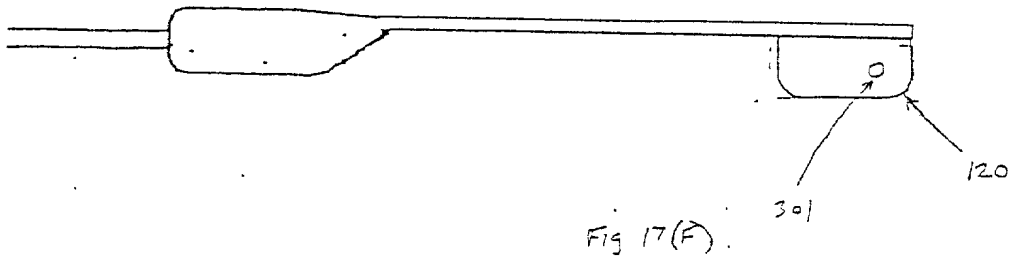
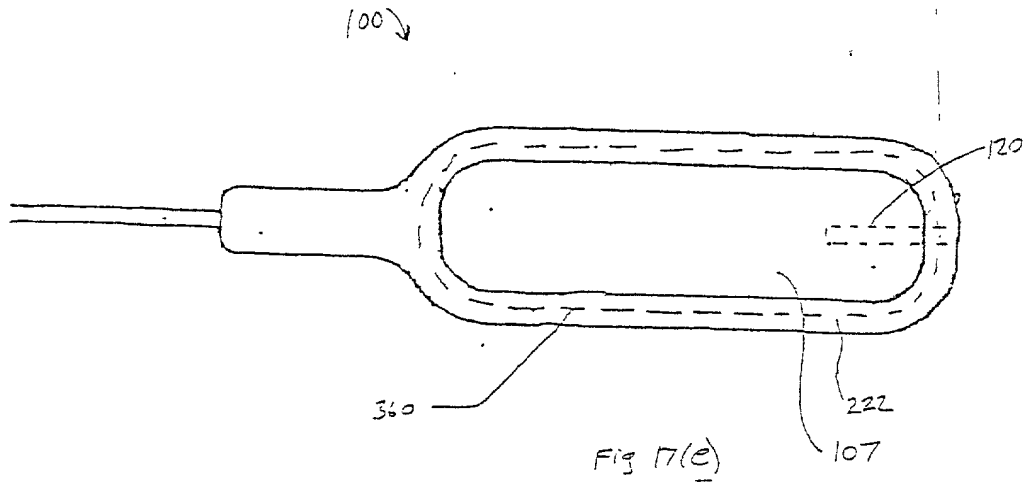


FIG. 17(c)





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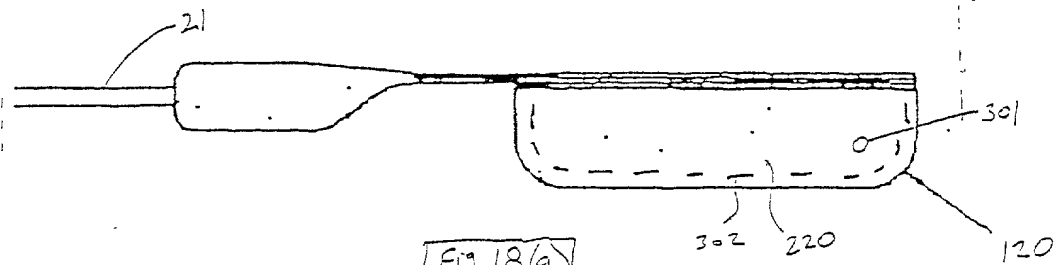


FIG 18(a)

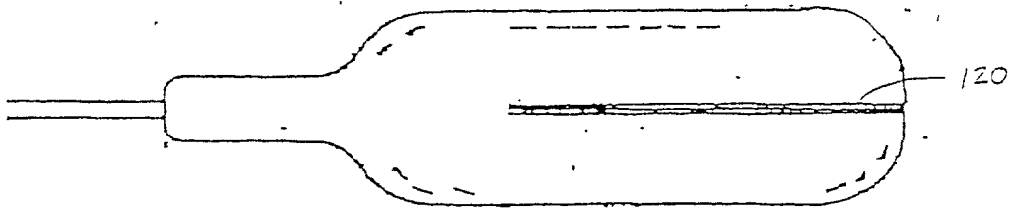


FIG 18(b)

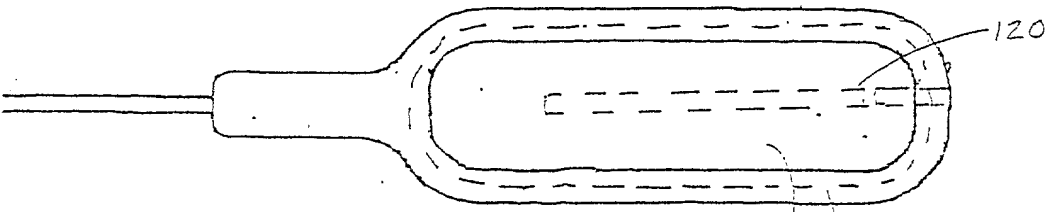


FIG 18(c)

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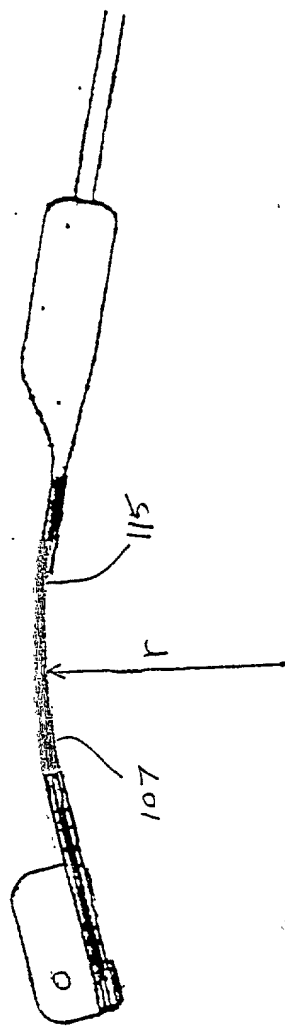


Fig. 19

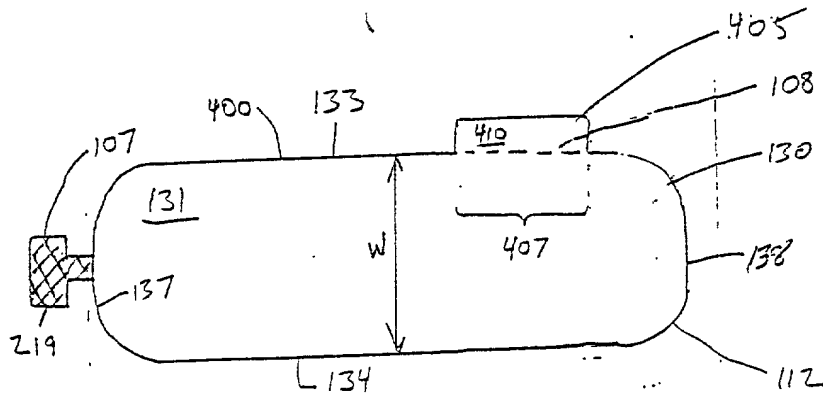


FIG. 20(a)

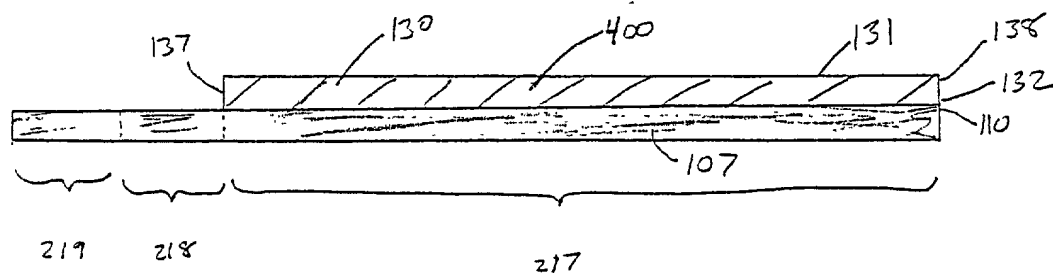
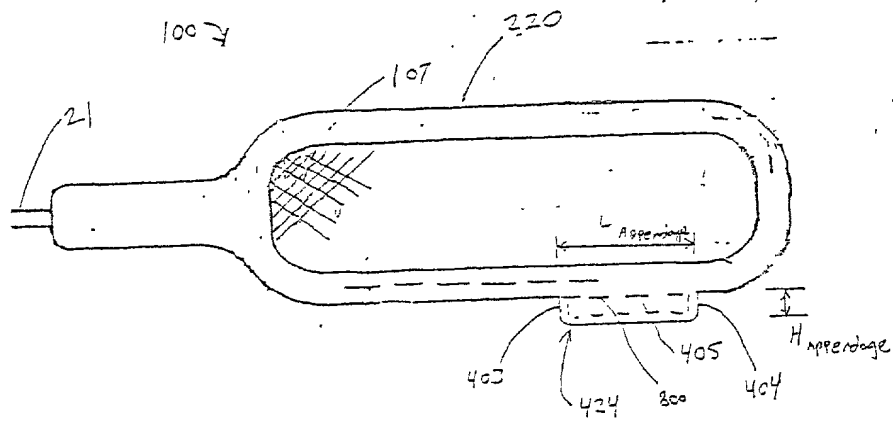


FIG. 20(b)

FIG. 20(C)



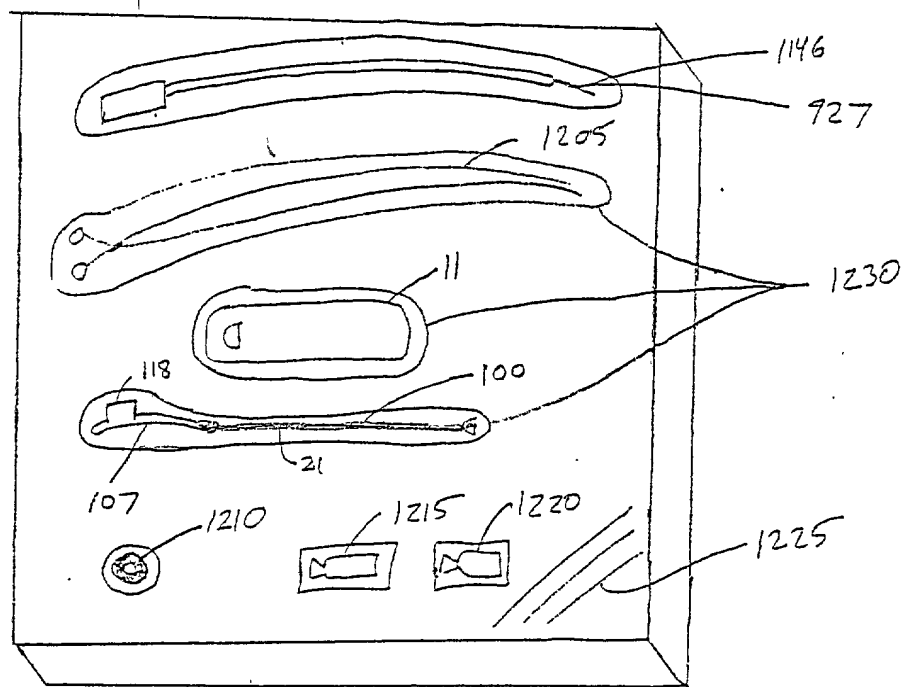


FIG. 41 (a)

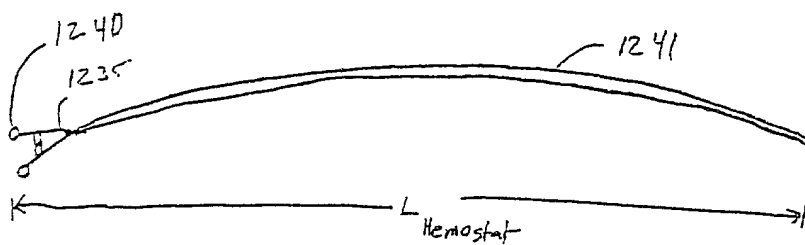


FIG. 41 (b)

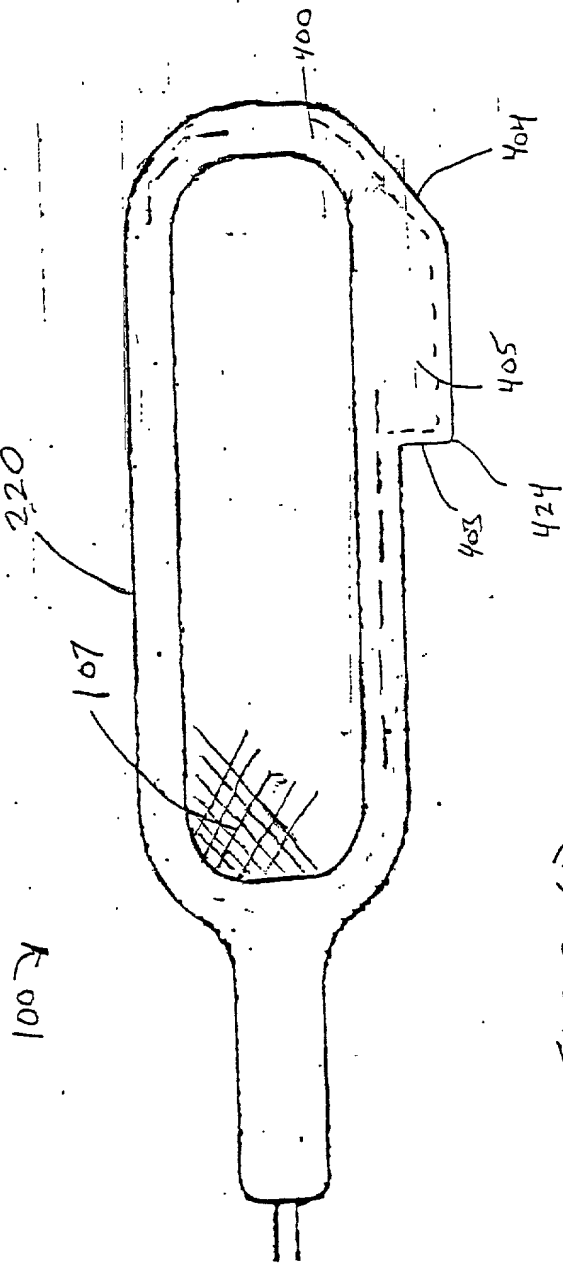


FIG. 20(d)

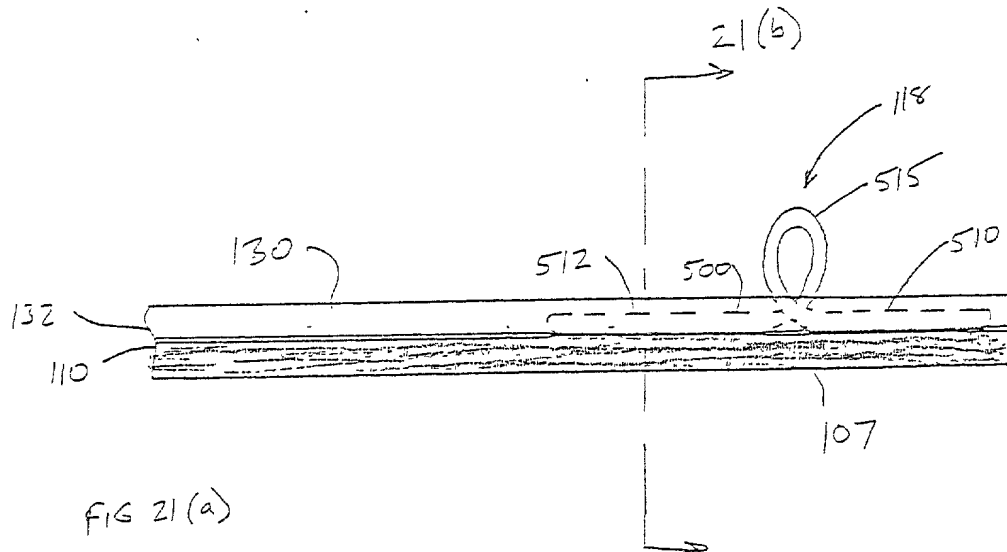


FIG. 21(a)

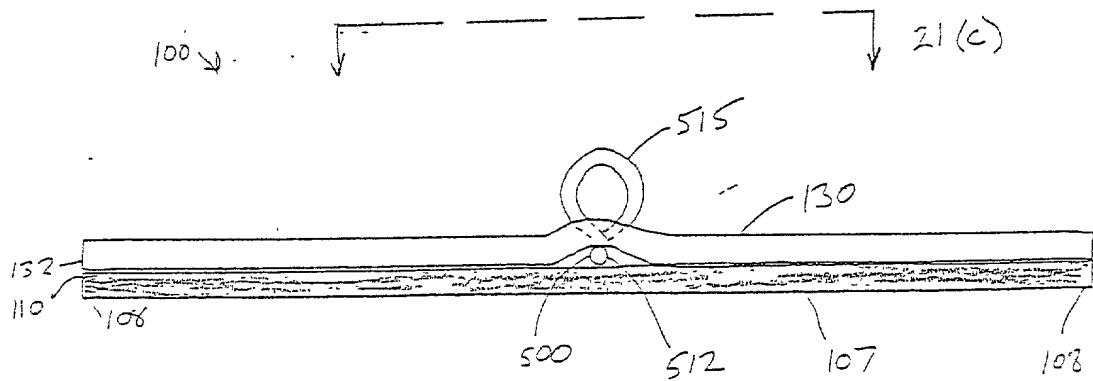


Fig. 21(b)

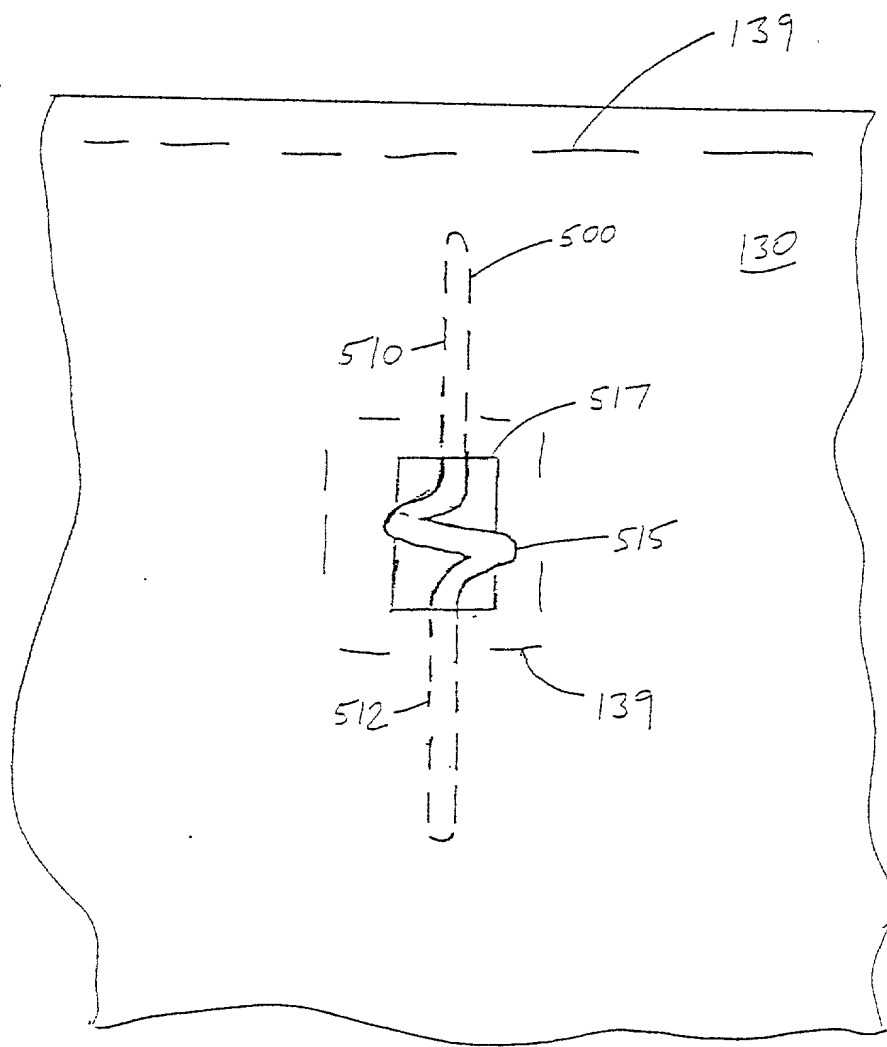


Fig 21 (c)

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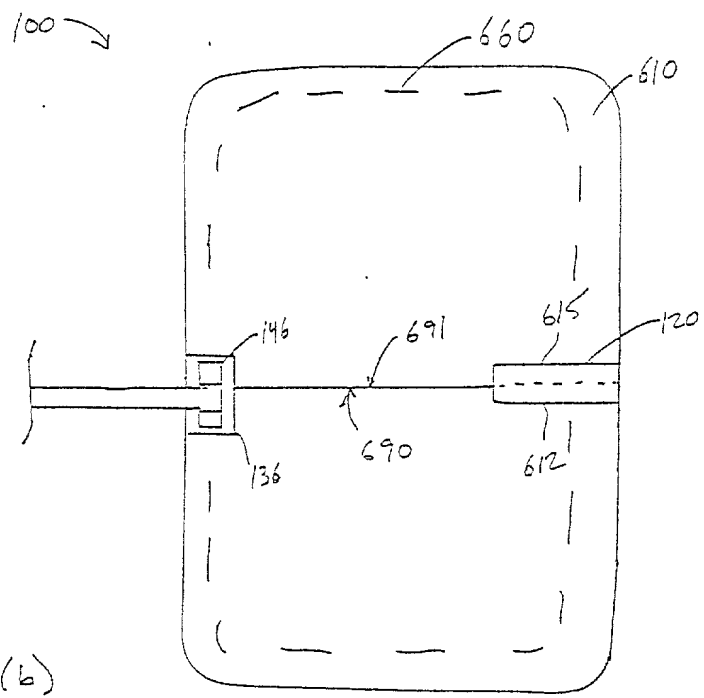


FIG. 22(b)

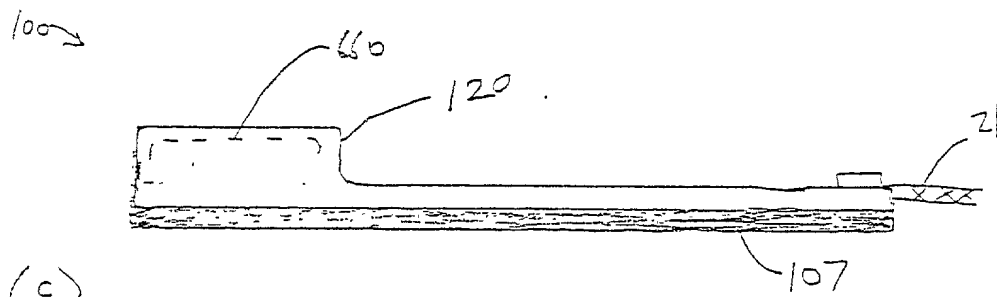


FIG. 22(c)

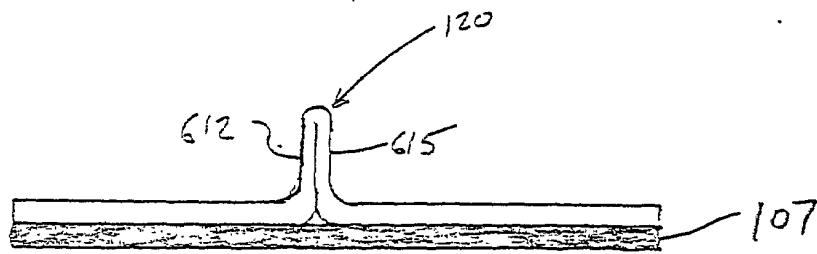
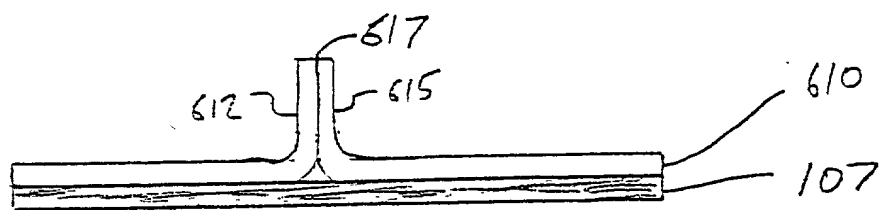
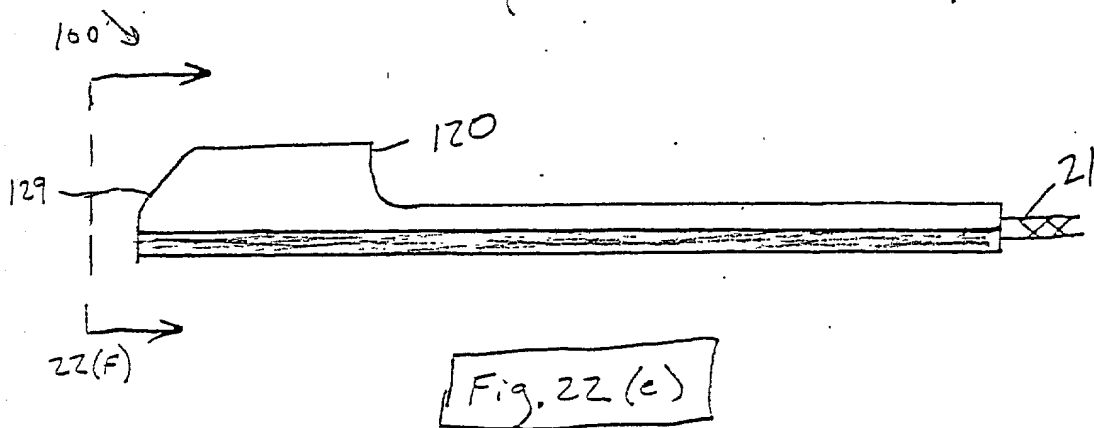


FIG 22 (d)

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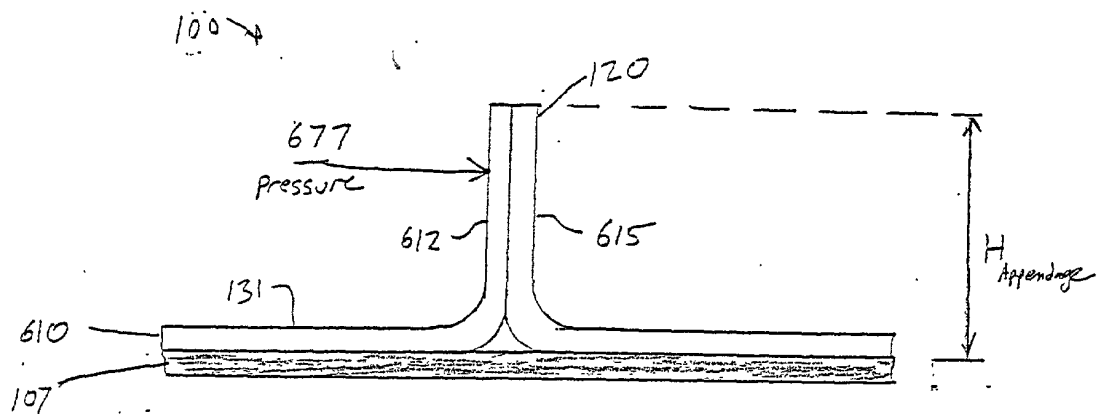


FIG. 23(a)

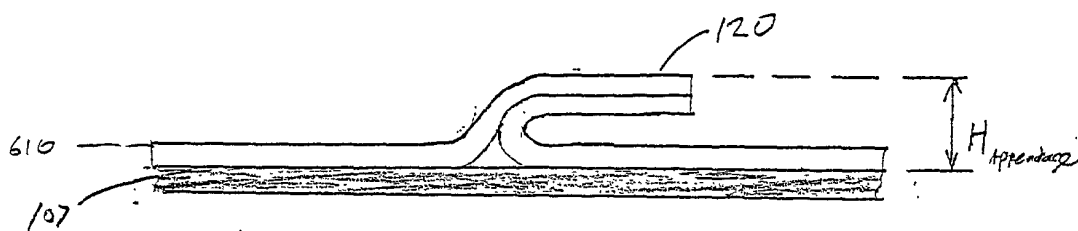


FIG. 23(b)

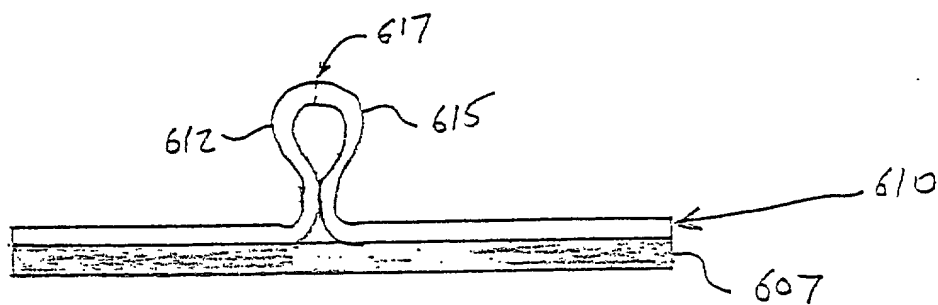


Fig. 24 (a)

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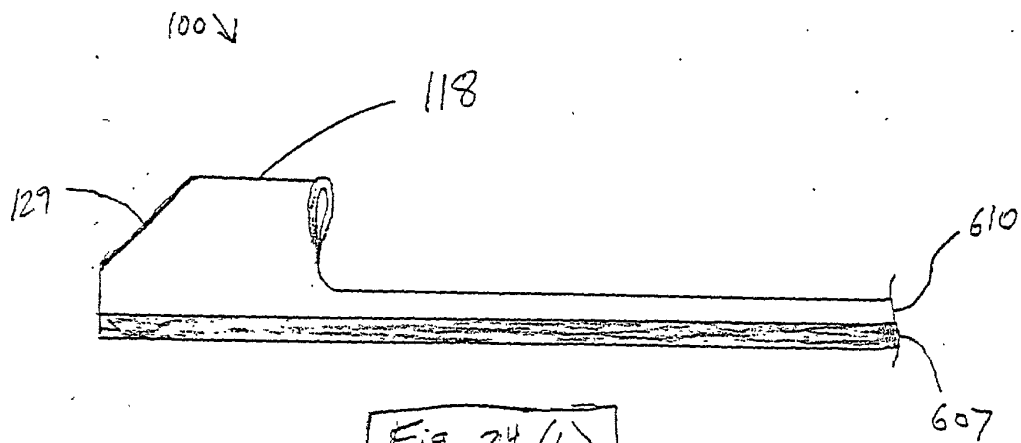


Fig 24 (6)

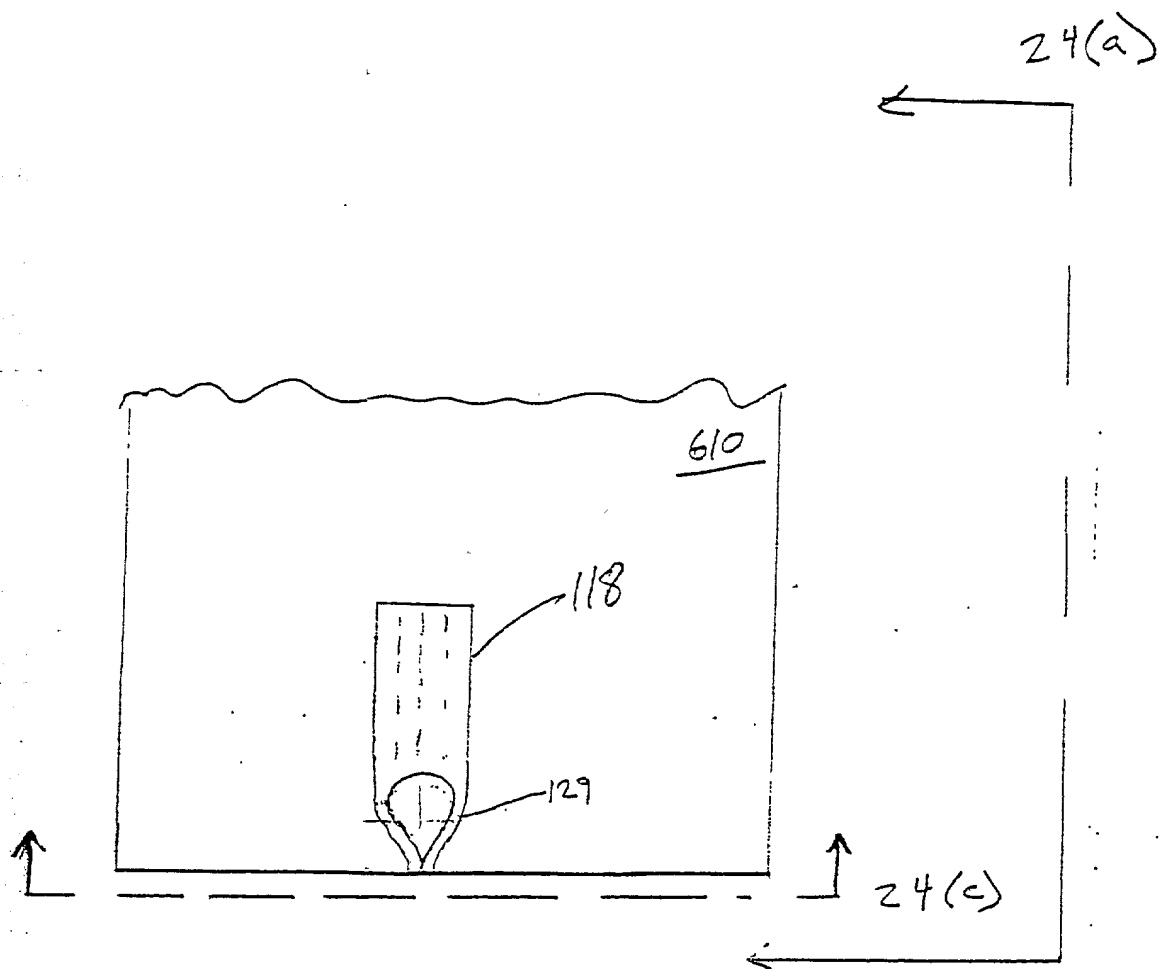


FIG. 24(c)

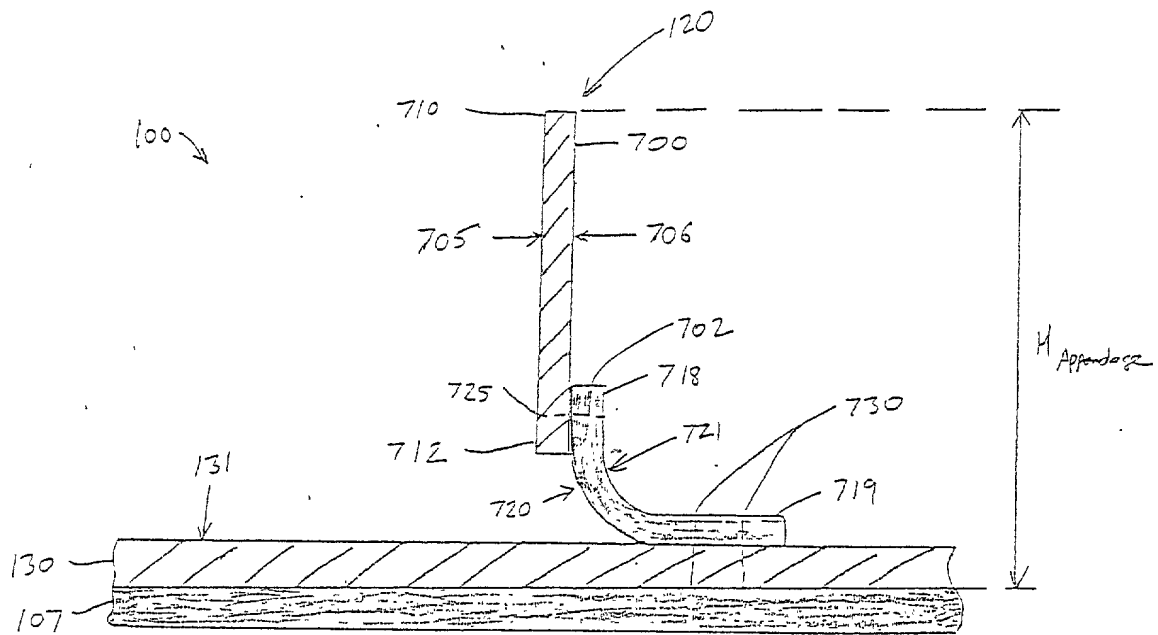


FIG. 25(a)

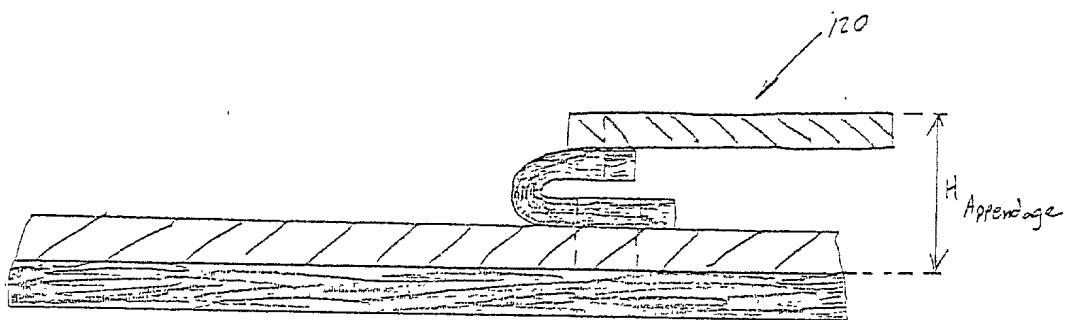


FIG. 25(b)

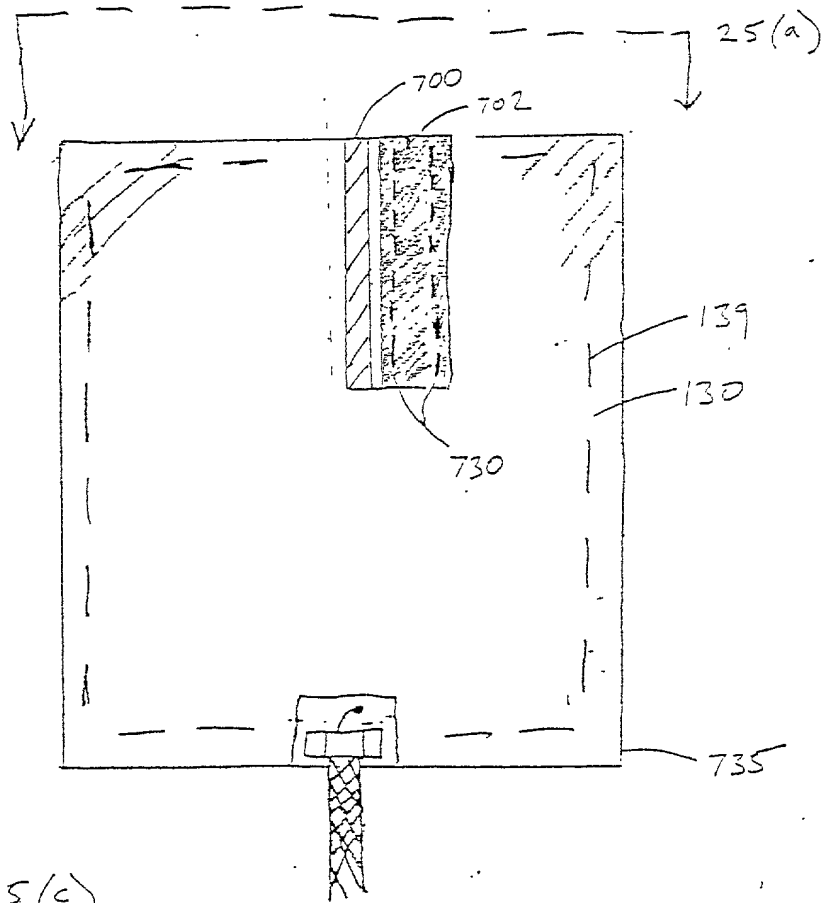


FIG. 25(c)

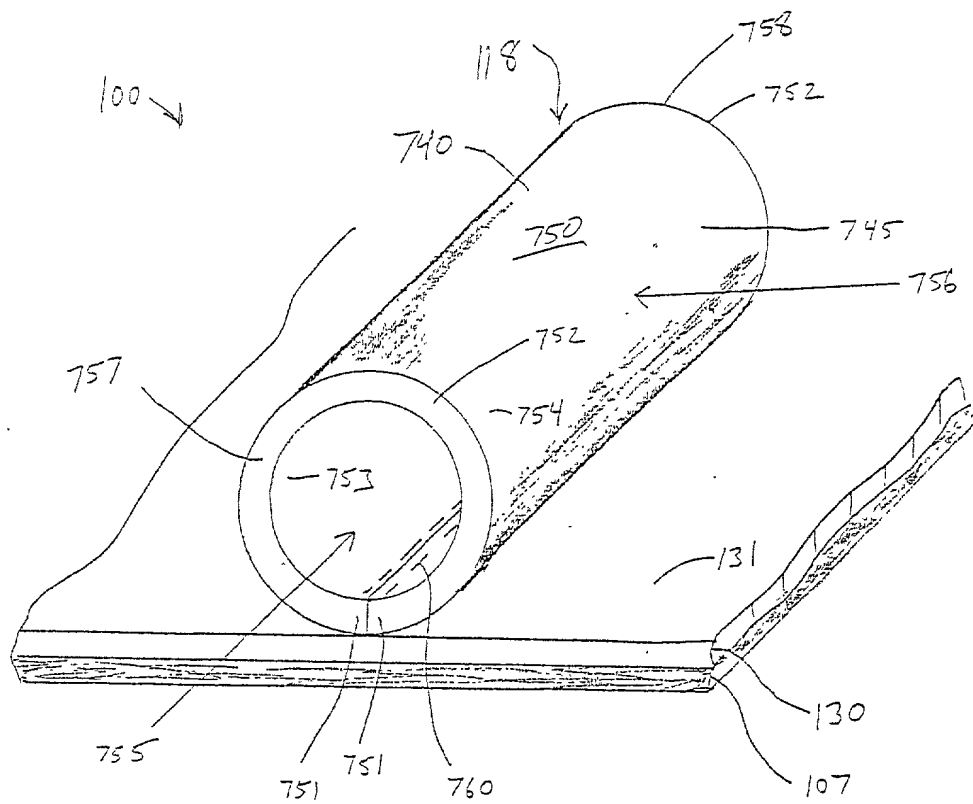


FIG. 26

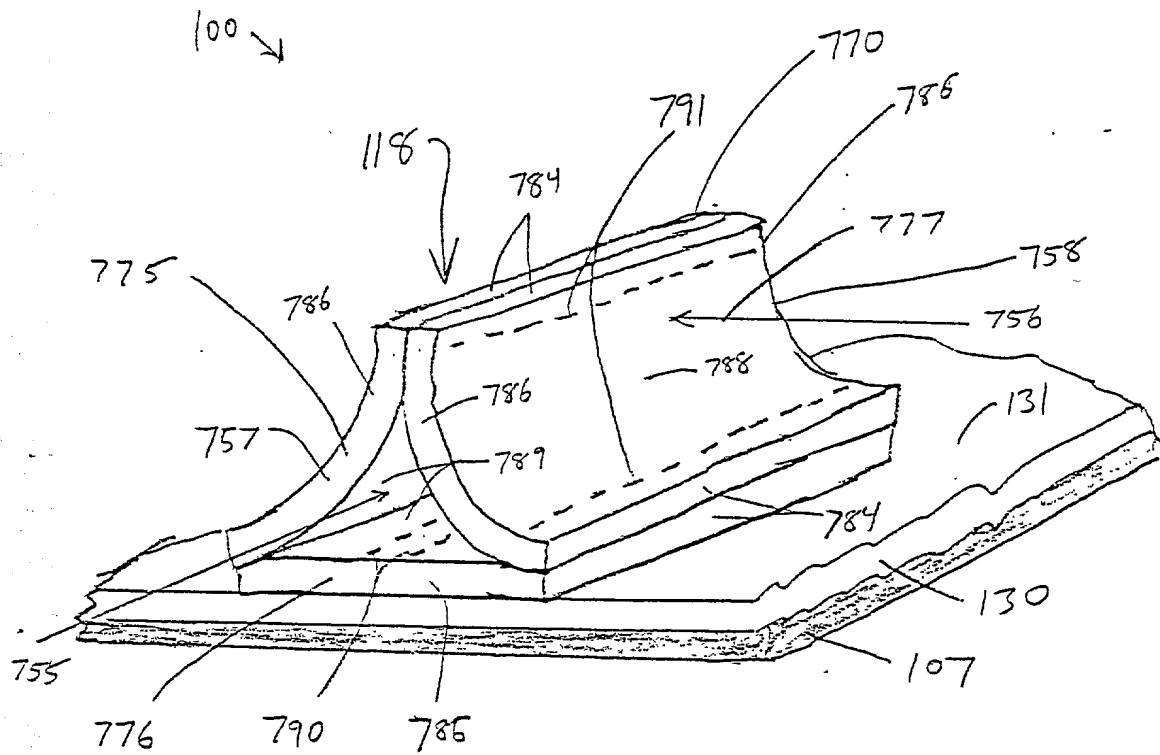


FIG. 27

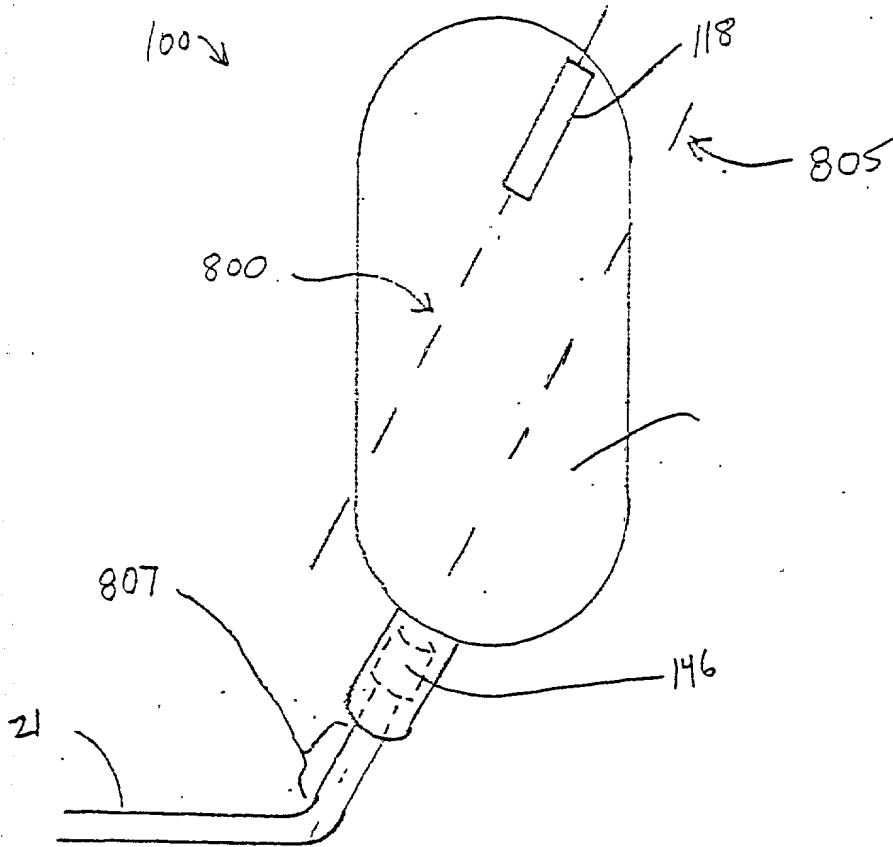
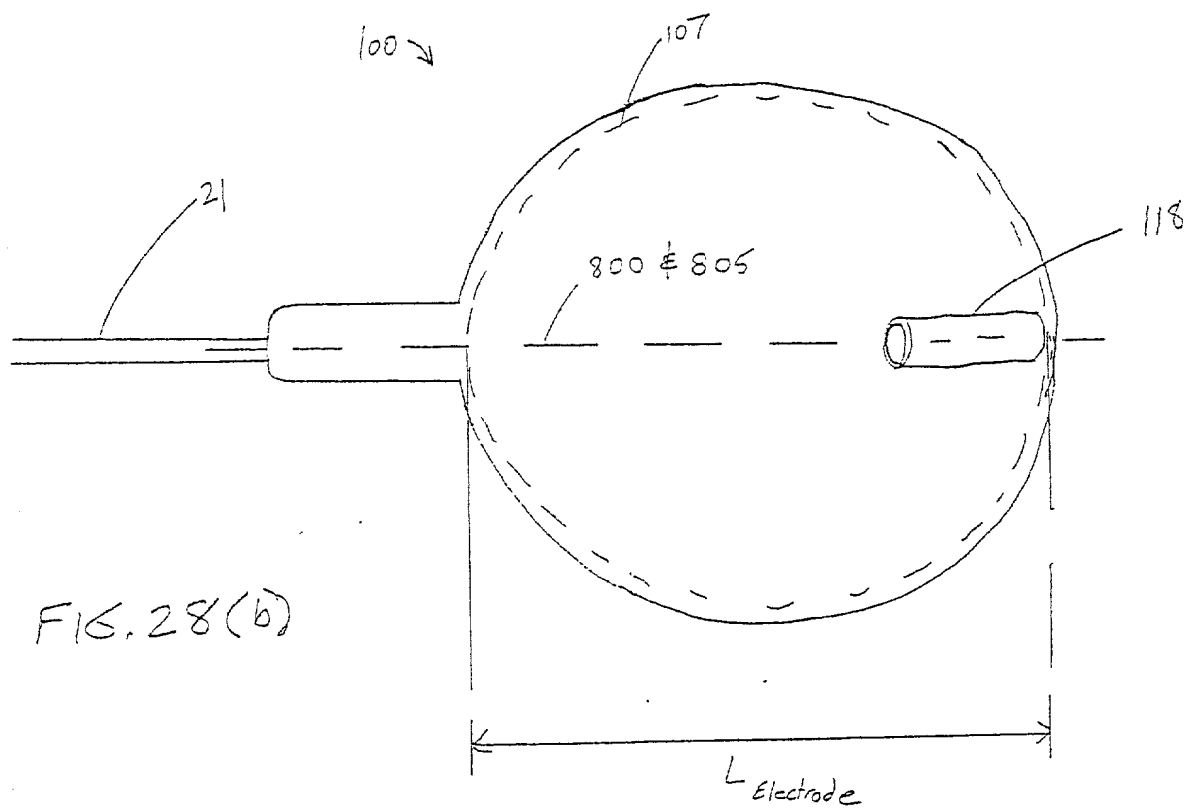


FIG. 28(a)



F15. 28(4)

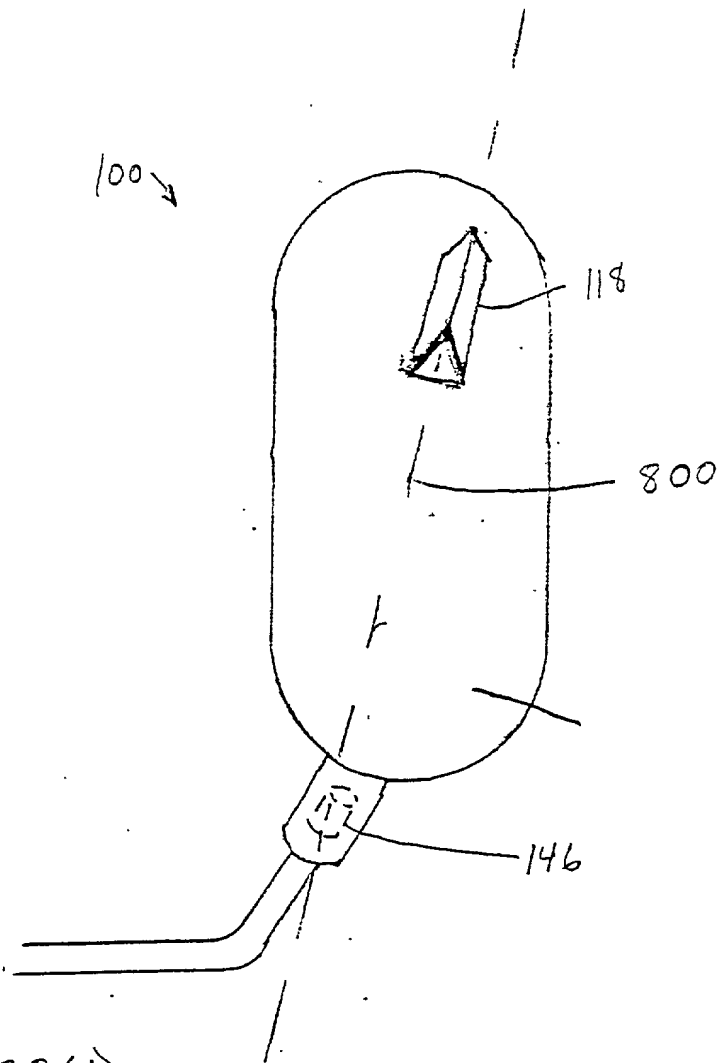


FIG. 28(d)

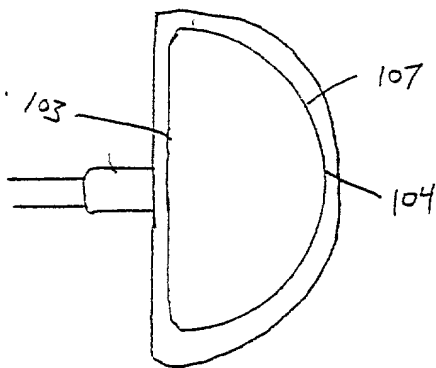


FIG. 28(e)

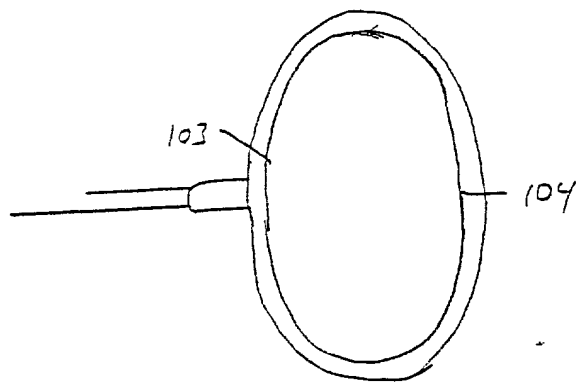


FIG. 28(f)

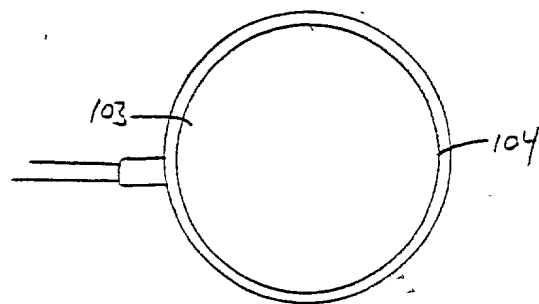


FIG. 28(g)

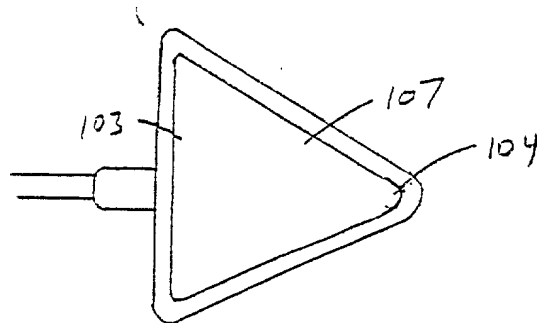


FIG. 28(h)

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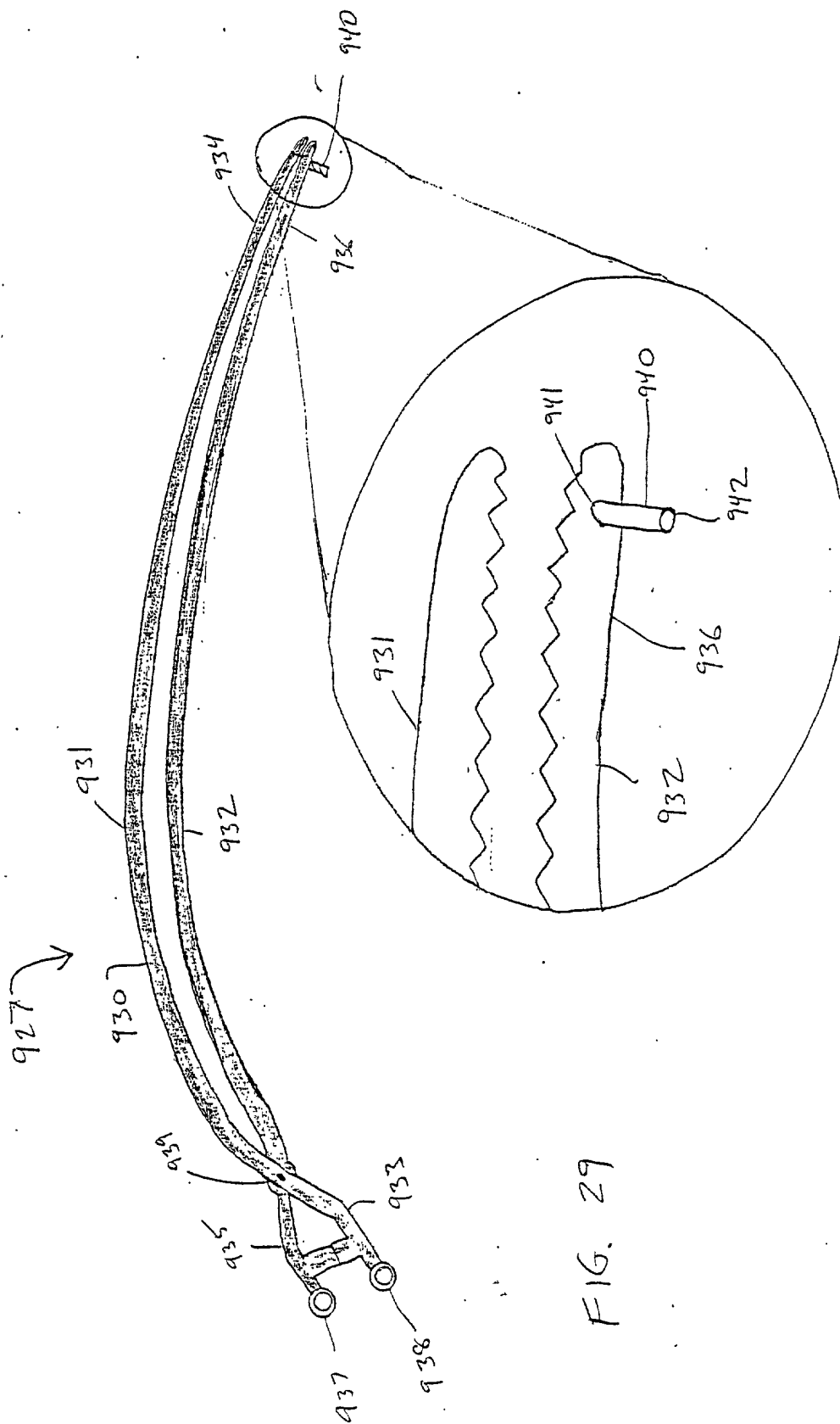


FIG. 29

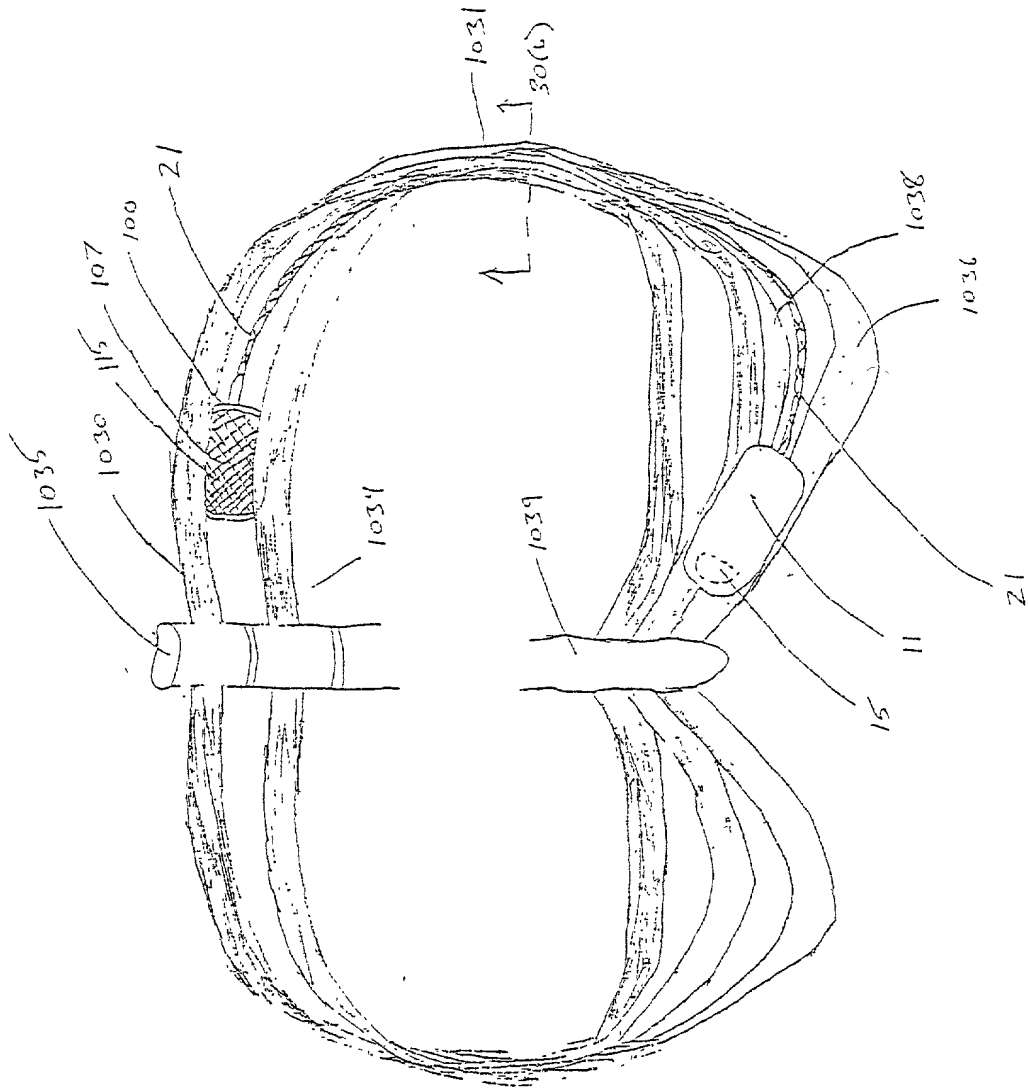


FIG 30(a)

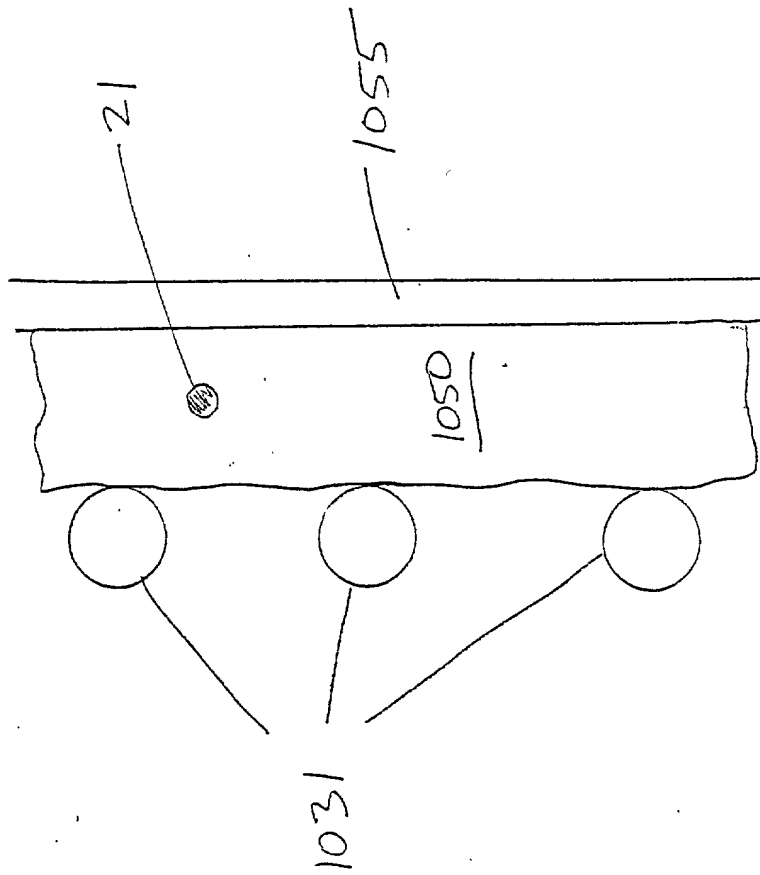
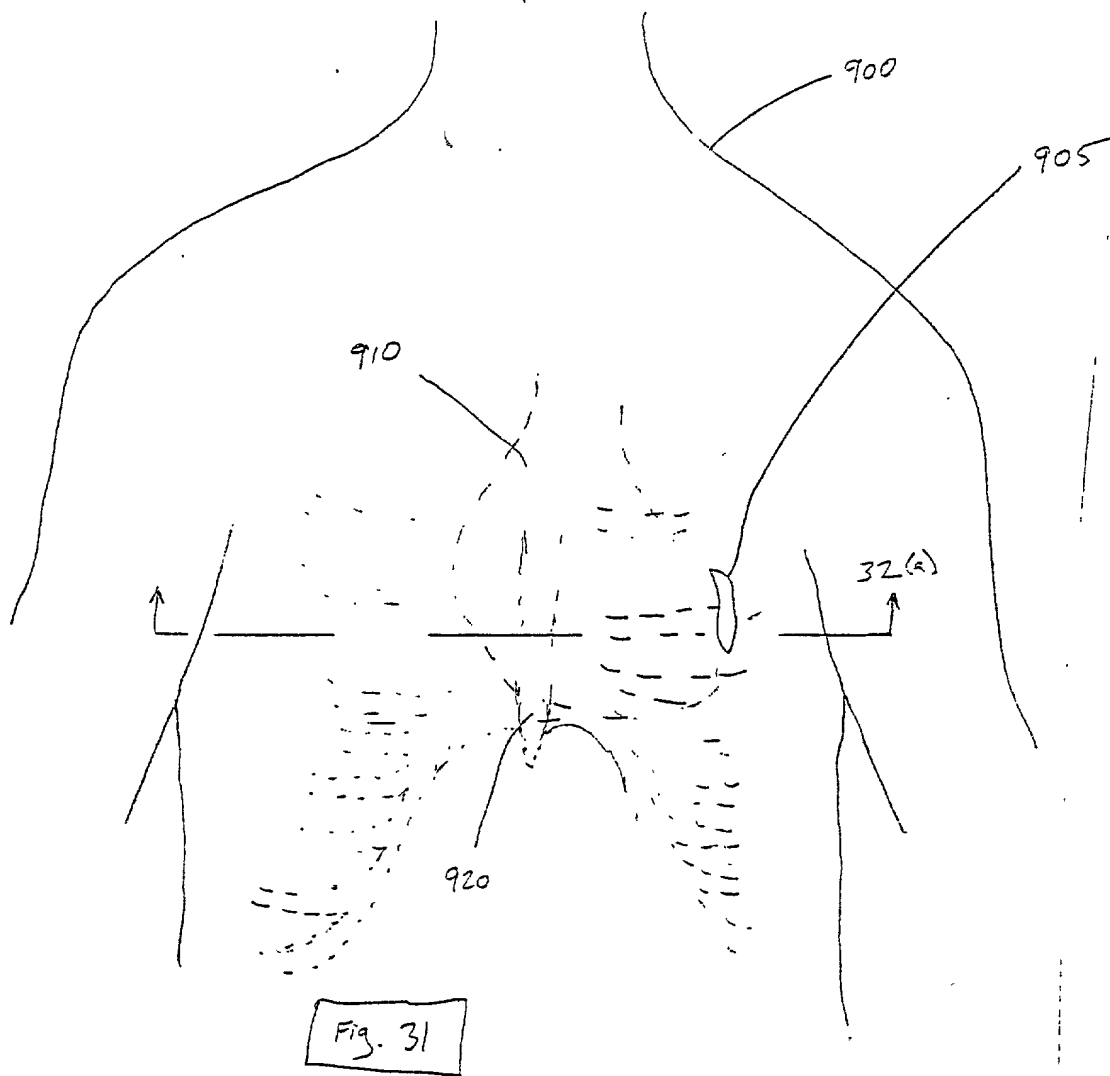


FIG 30 (b)



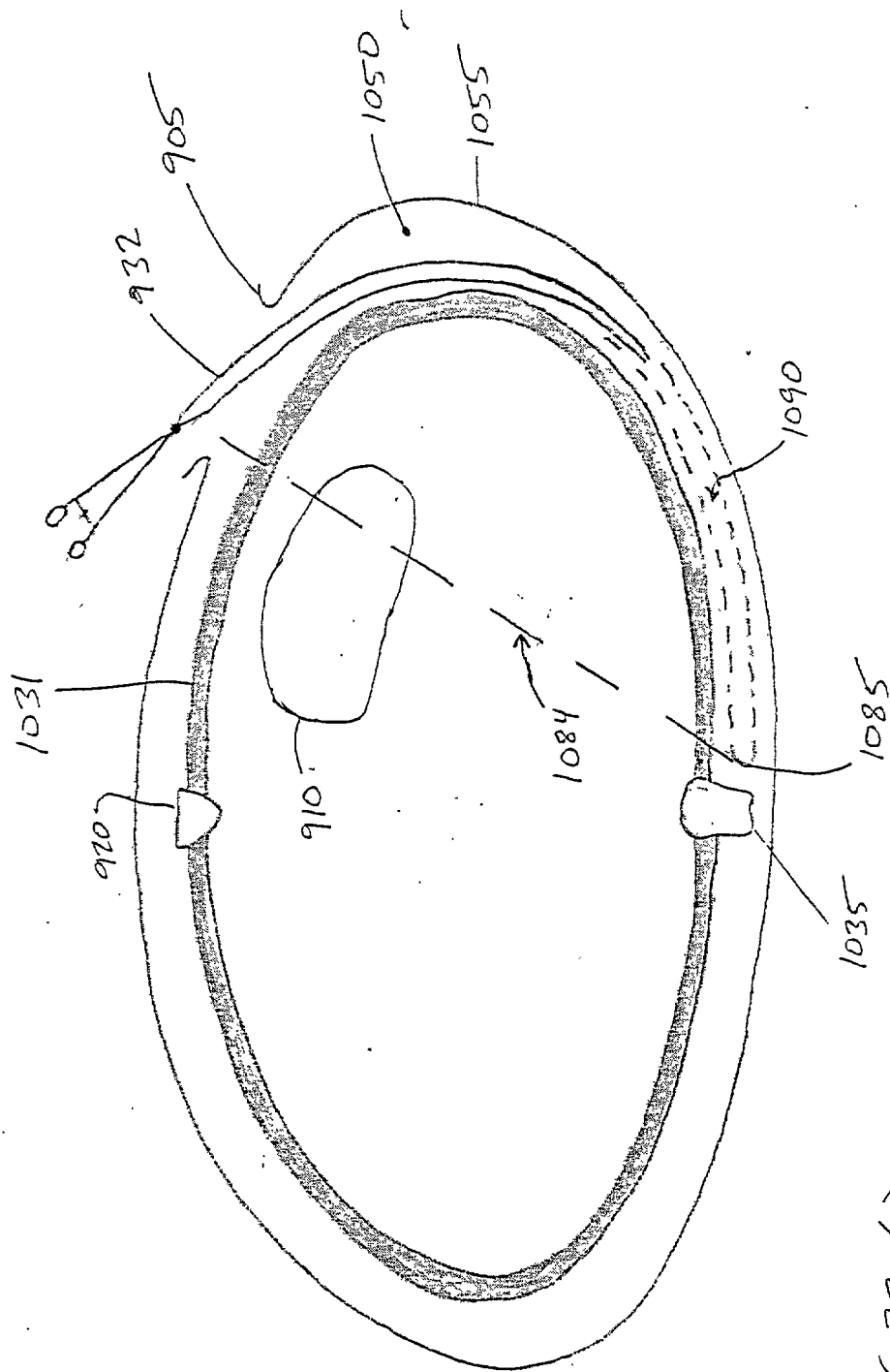
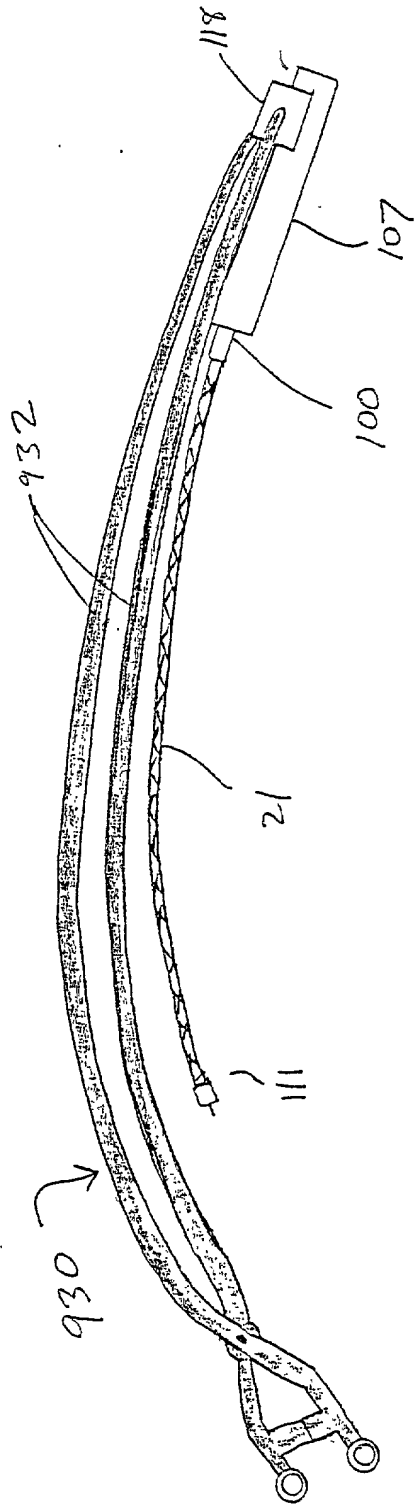
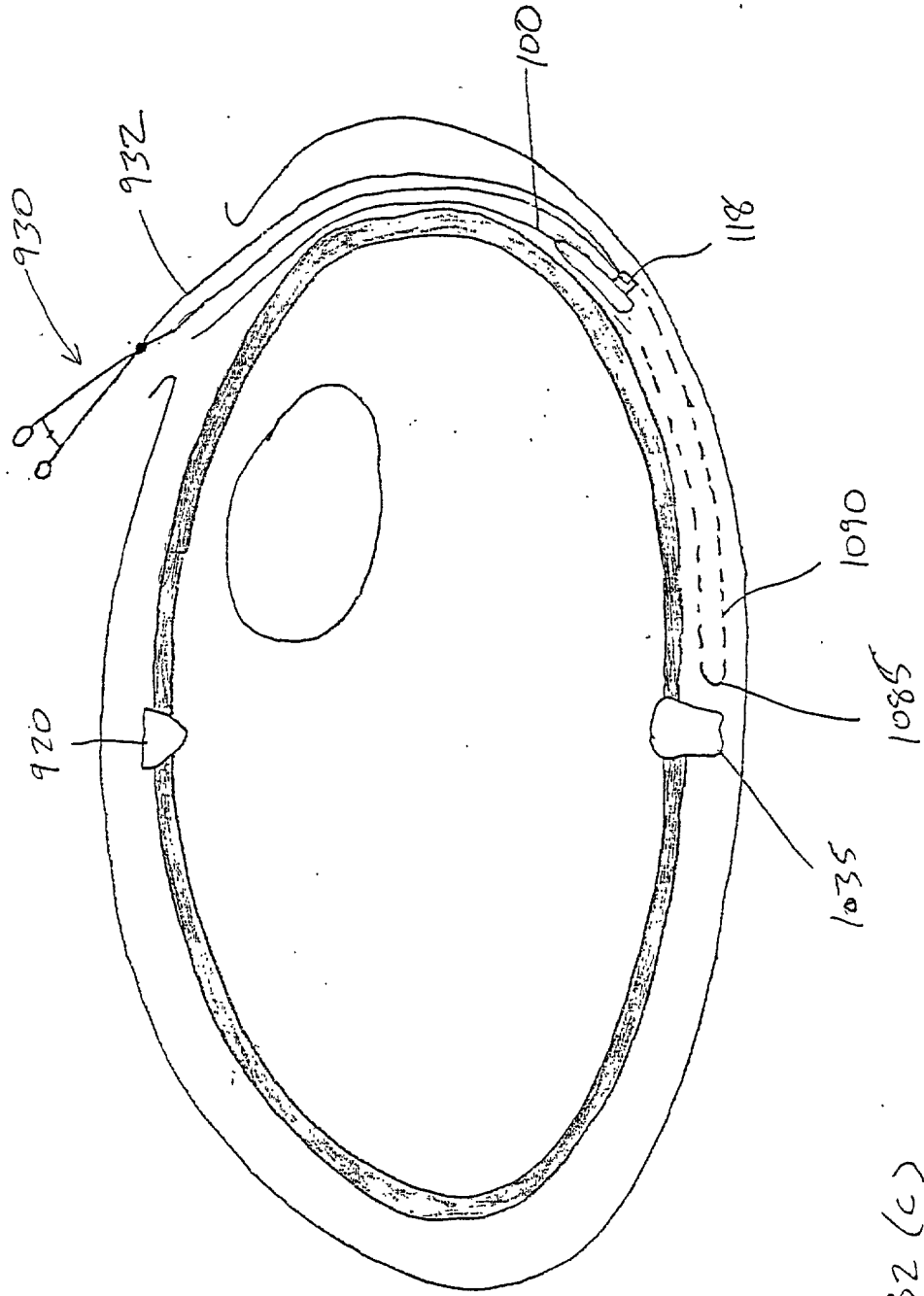


FIG. 32 (a)



32(b)



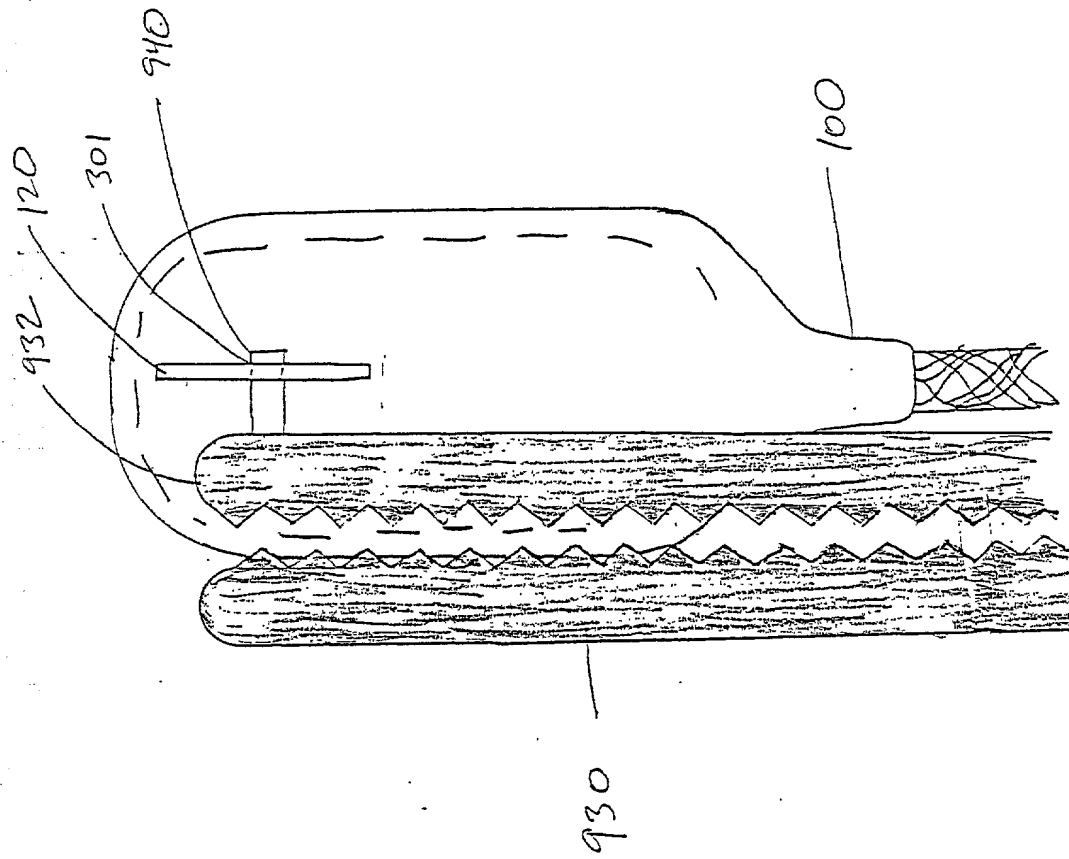


FIG. 32(d)

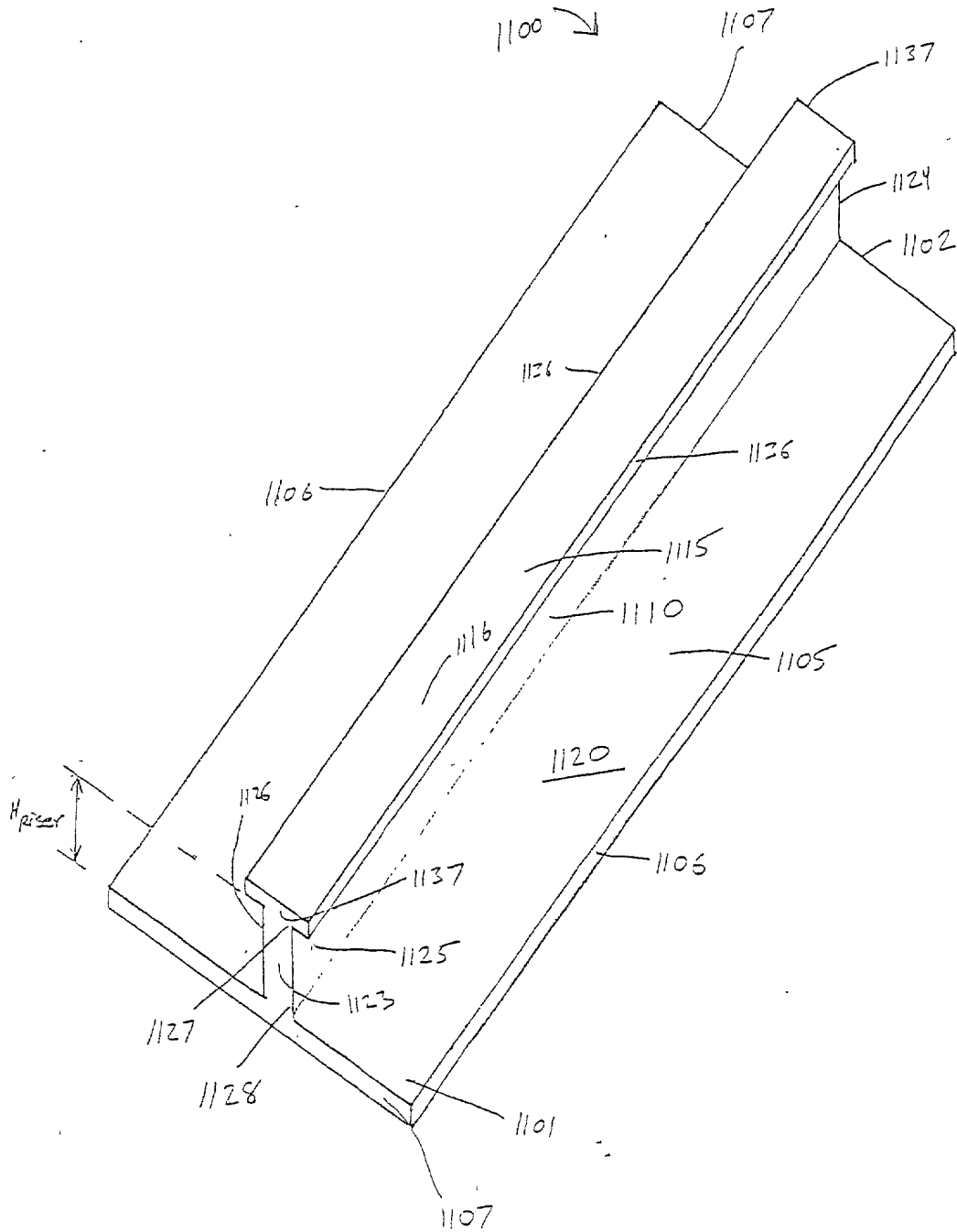


FIG 33(a)

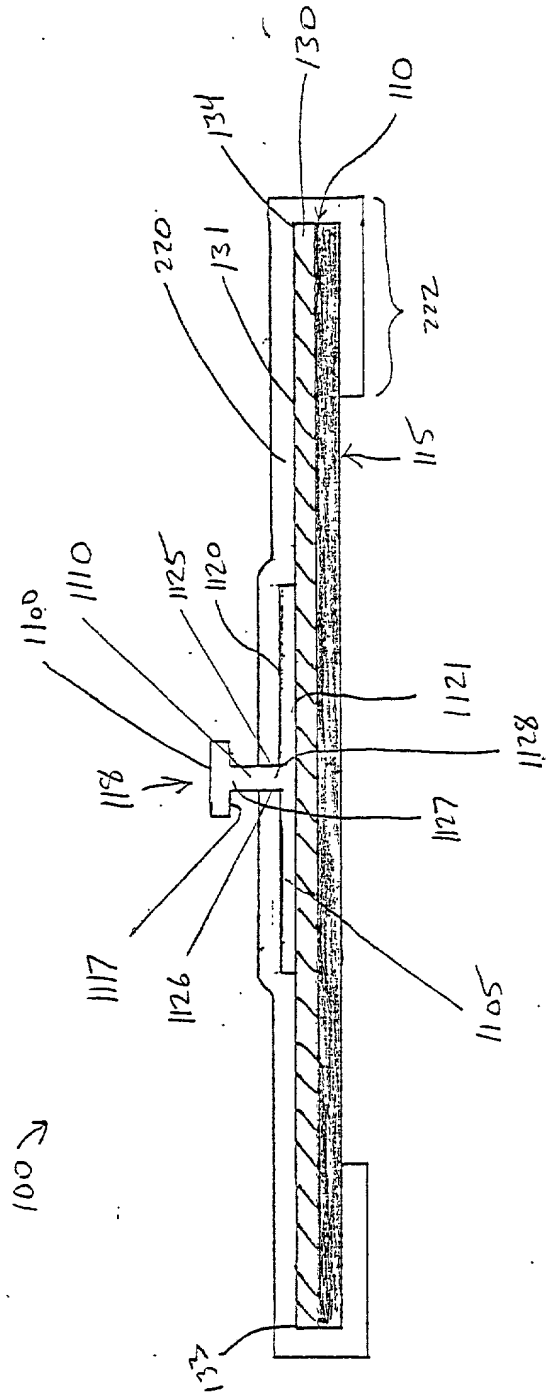


FIG. 33(b)

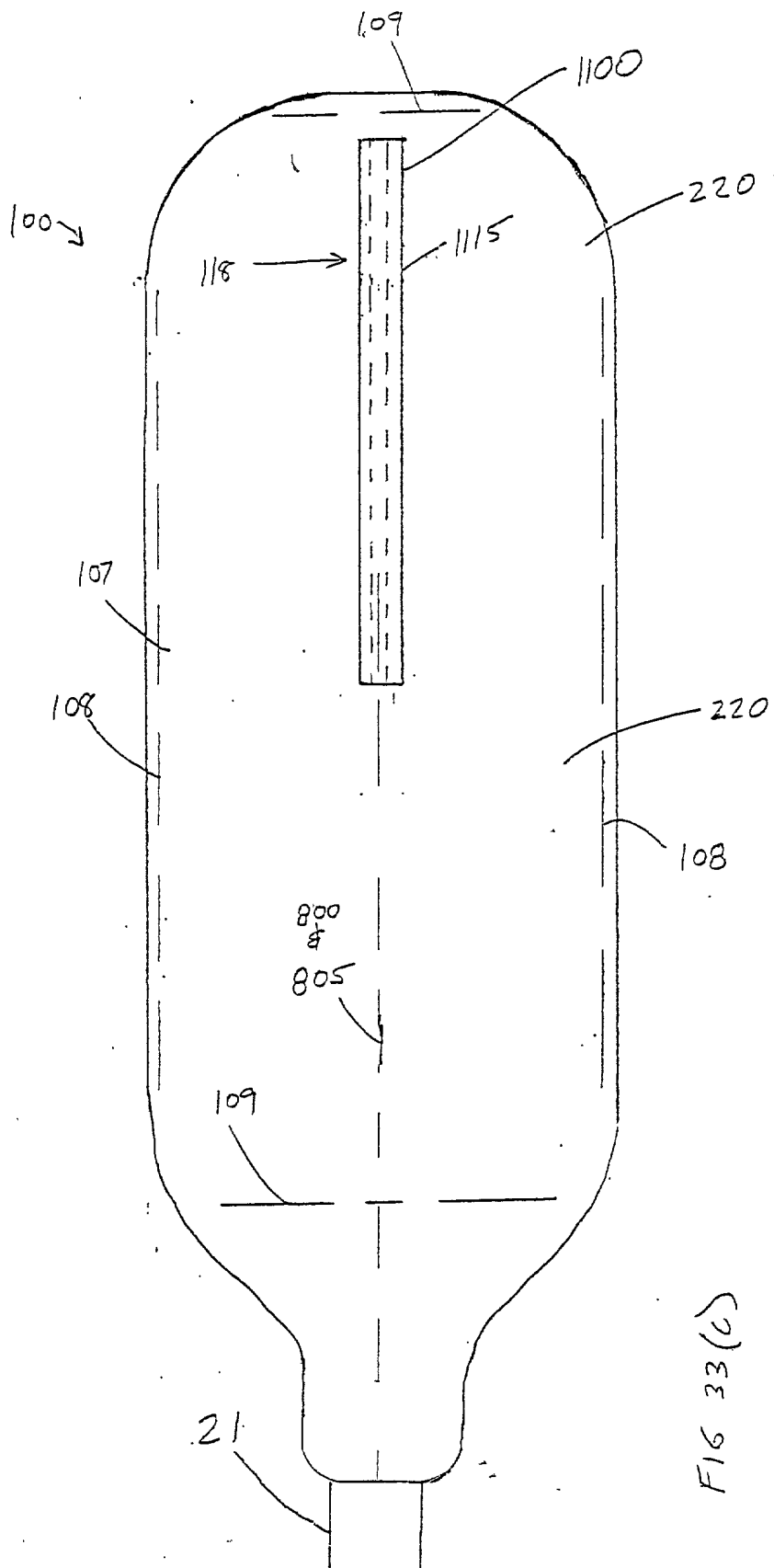
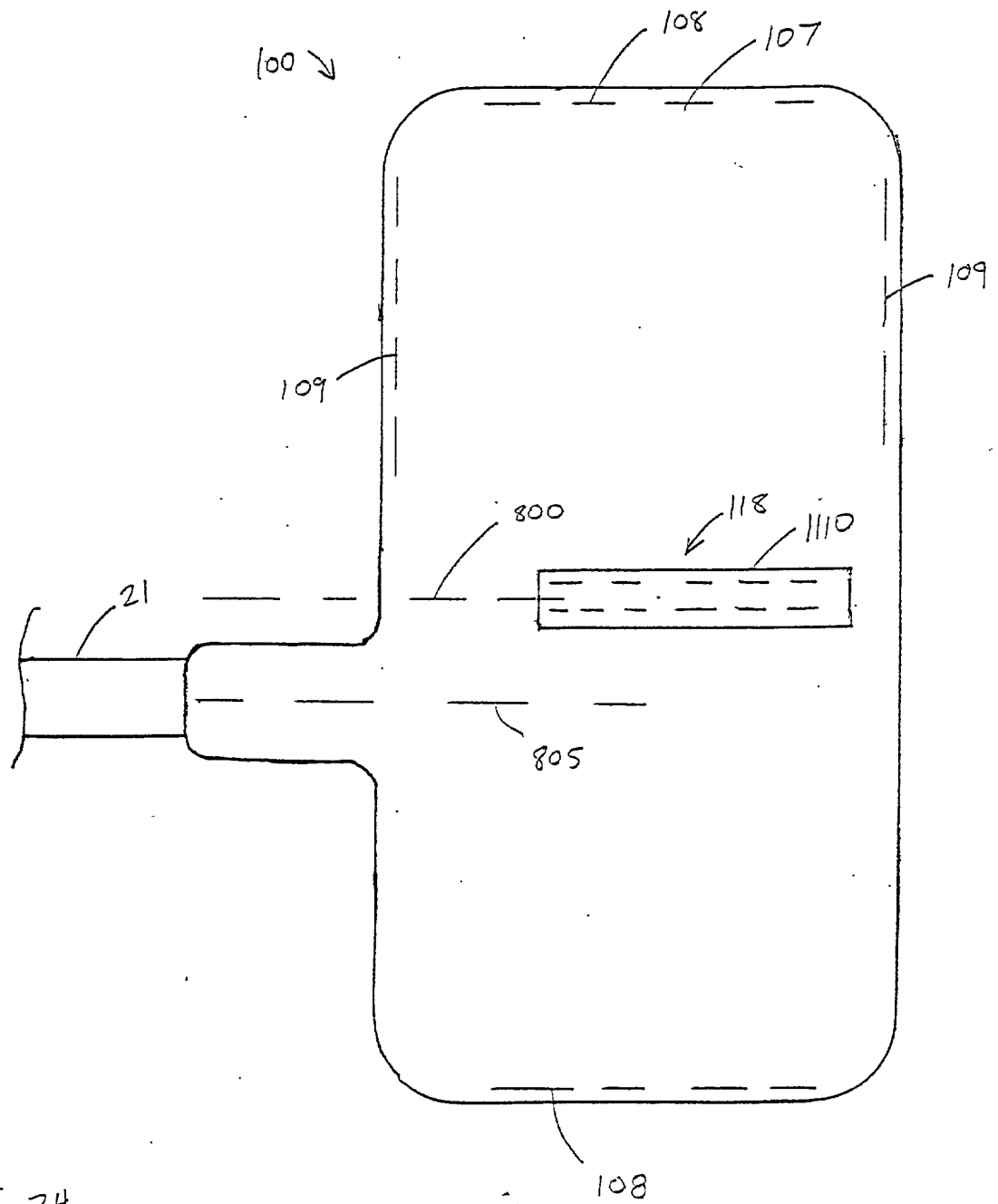


FIG 34



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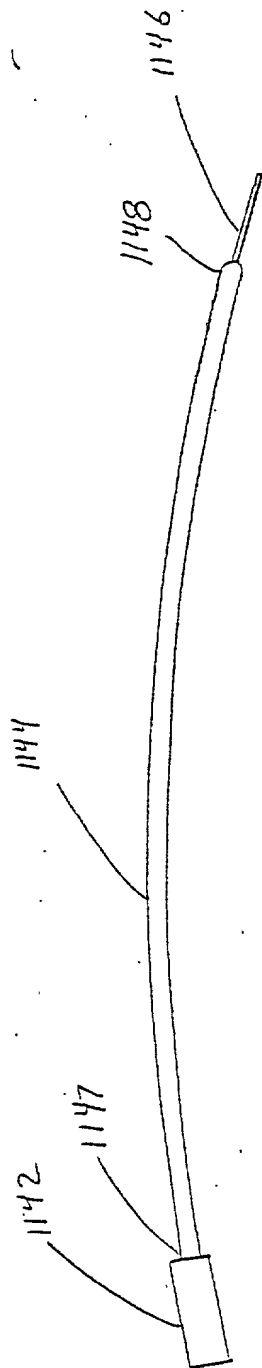
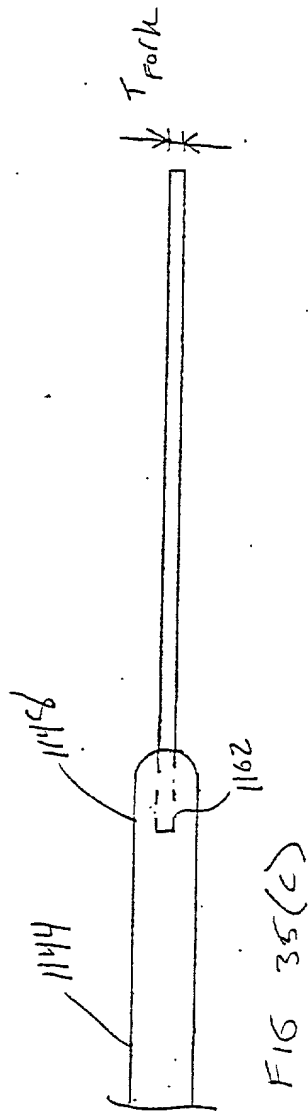
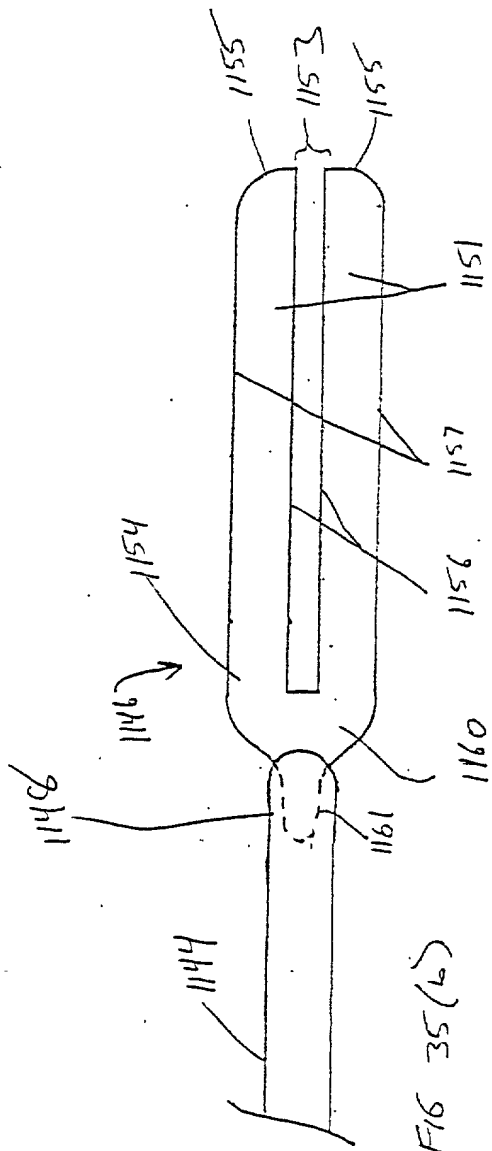


FIG 35 (a)



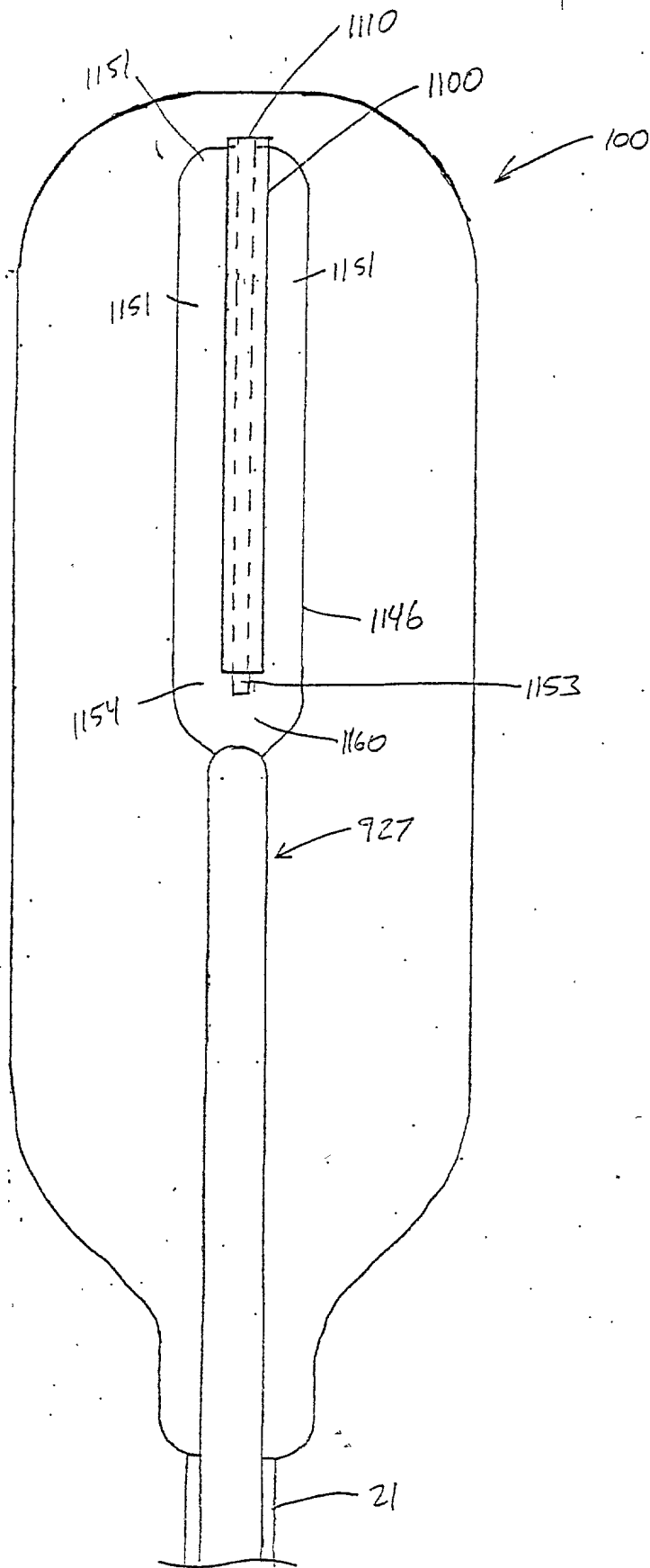


FIG 35(a)

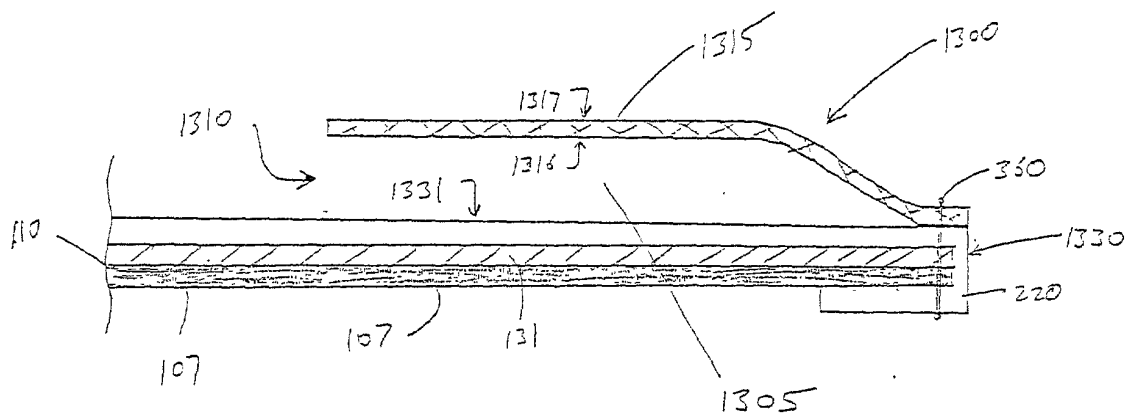


FIG. 36(a)

FIG. 36 (b)

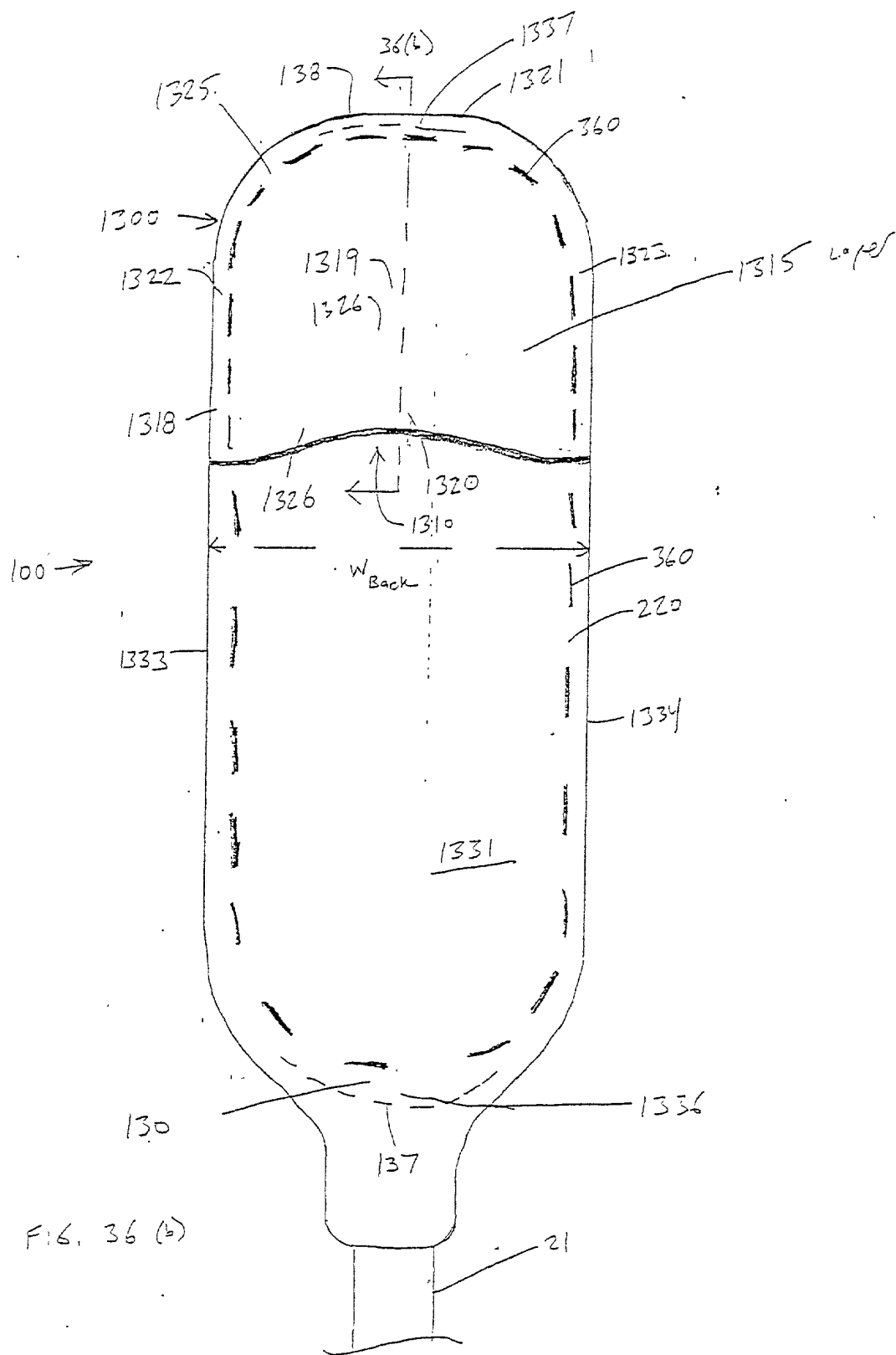
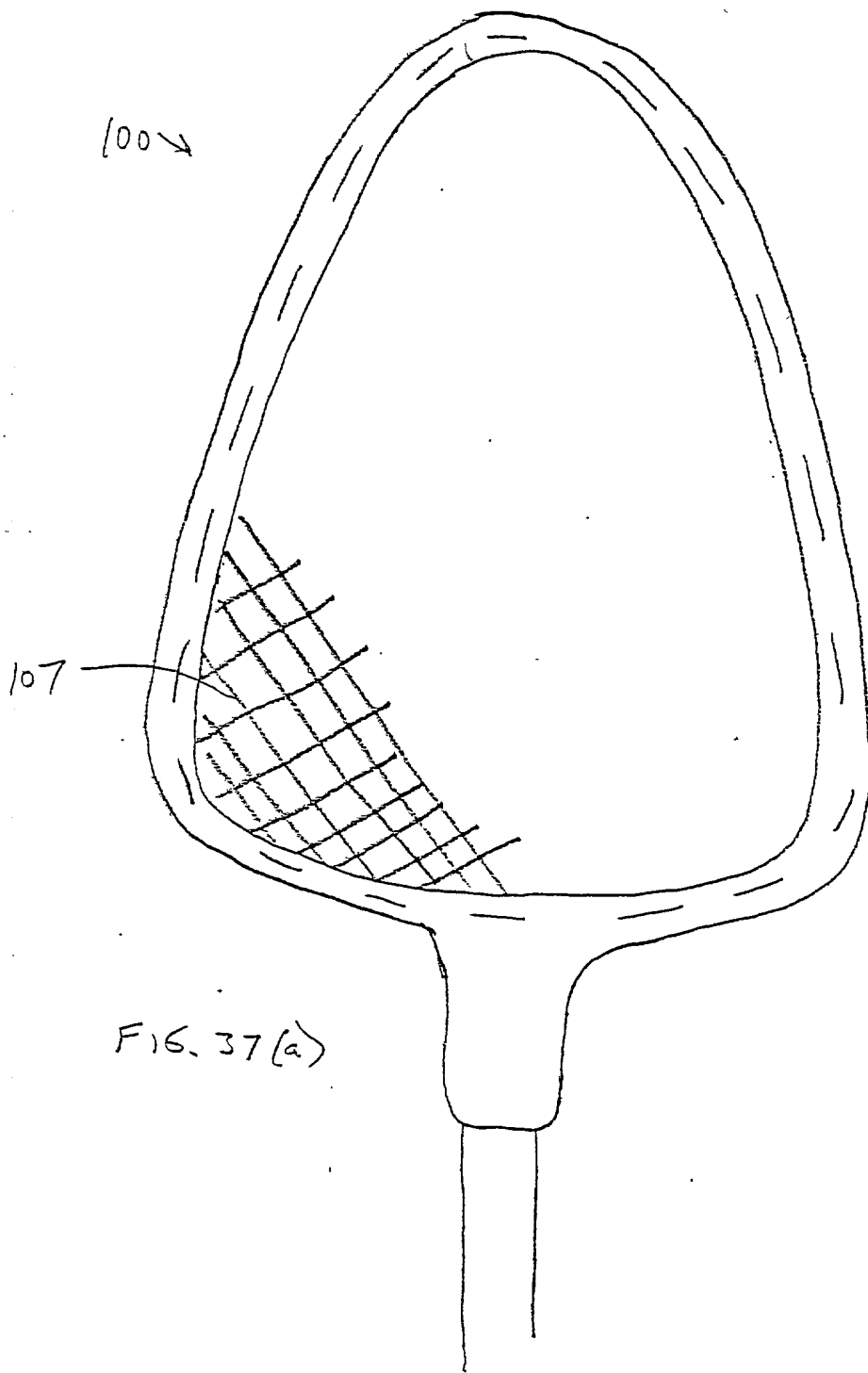


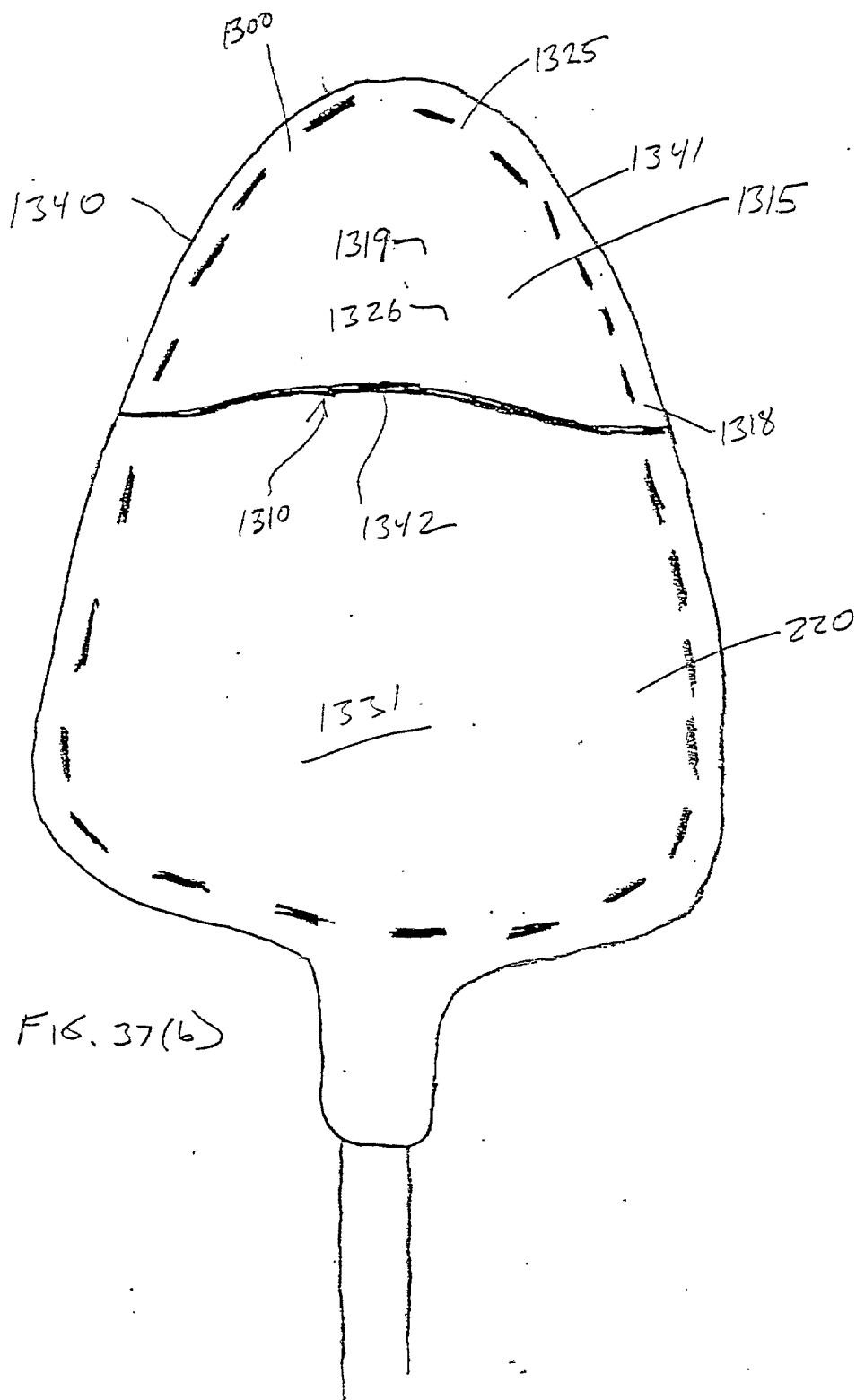
FIG. 36 (b)

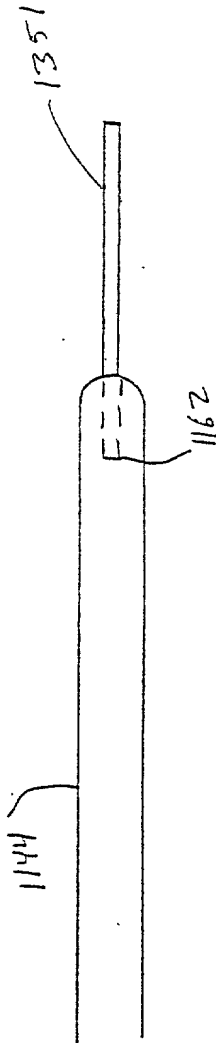
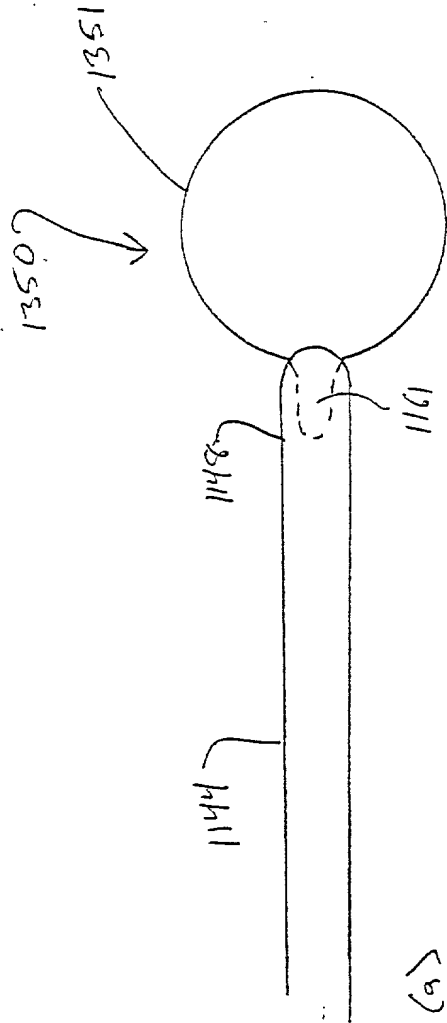
A cross-sectional view of a device assembly. A horizontal base layer, labeled 107, is shown with diagonal hatching. On top of this base, there is a rectangular block labeled 120, also with diagonal hatching. A curved, dome-like structure, labeled 1300, is positioned on top of the block 120. A layer labeled 180 is shown on the top surface of the curved structure 1300. To the left of the curved structure, a horizontal line labeled 220 is shown. A vertical line labeled 1305 is shown on the right side of the curved structure 1300. A small vertical dimension line labeled 183 is shown on the right side of the assembly.

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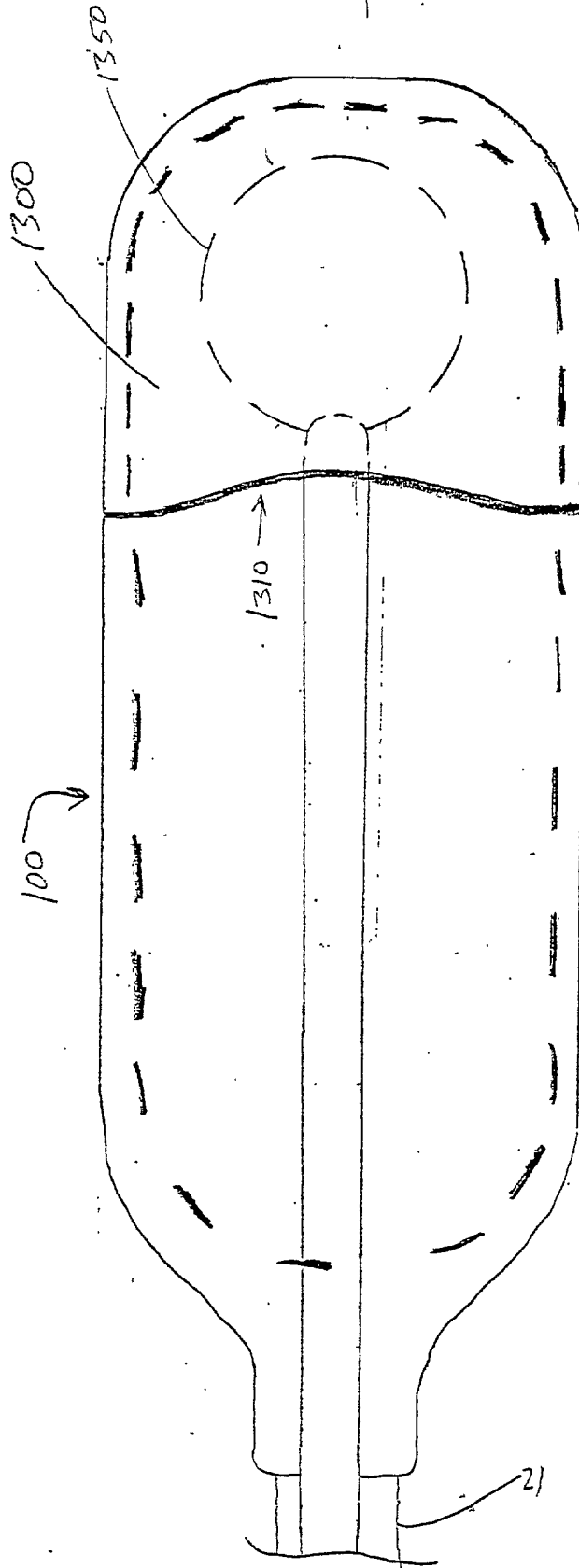


FIG. 38(c)

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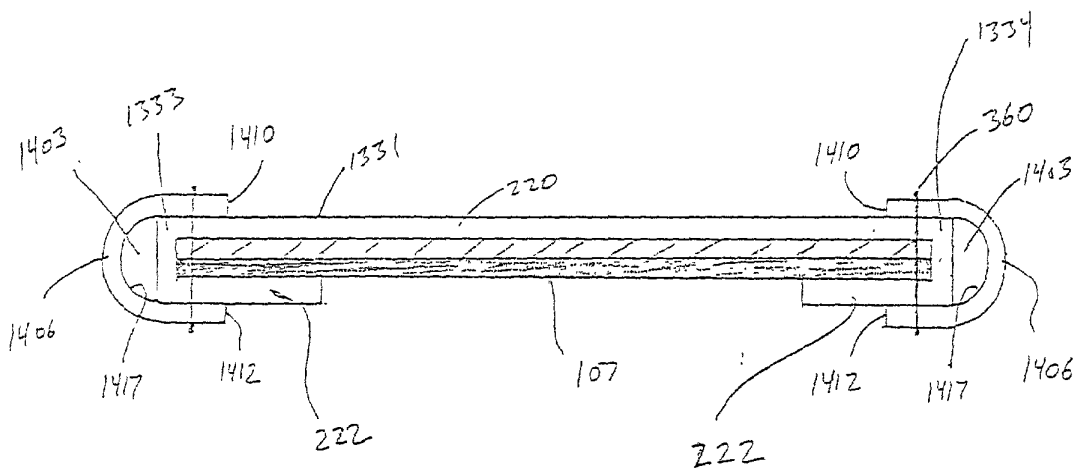
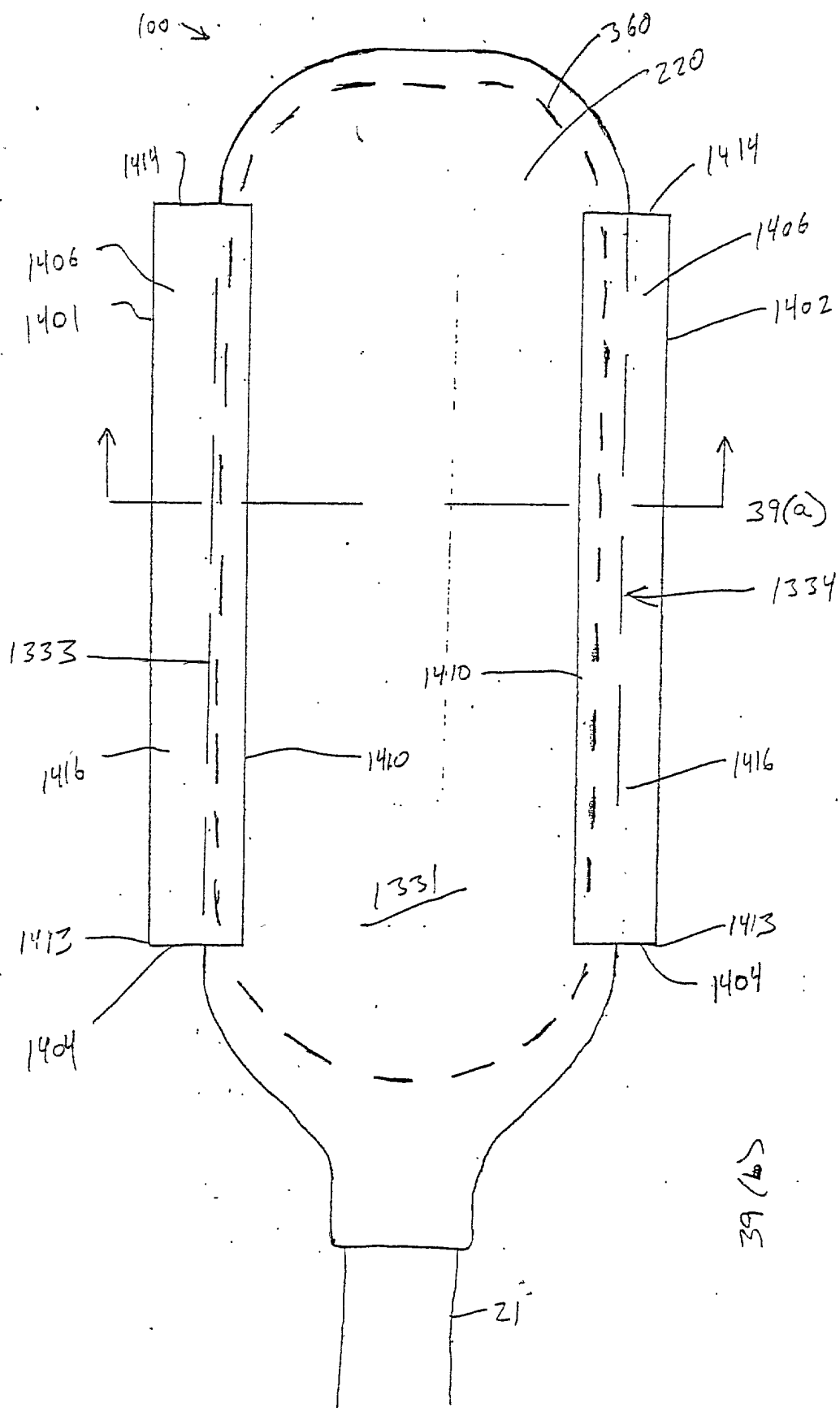
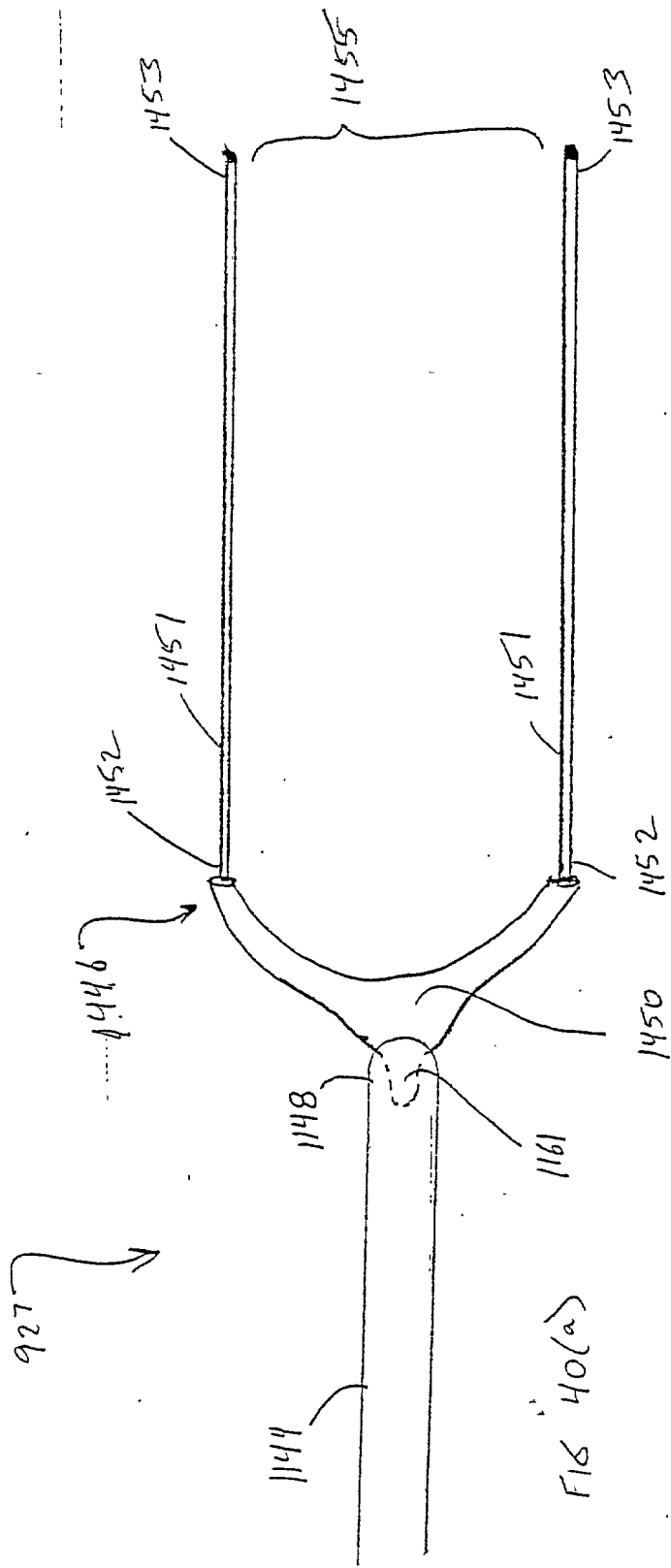


FIG 39(a)

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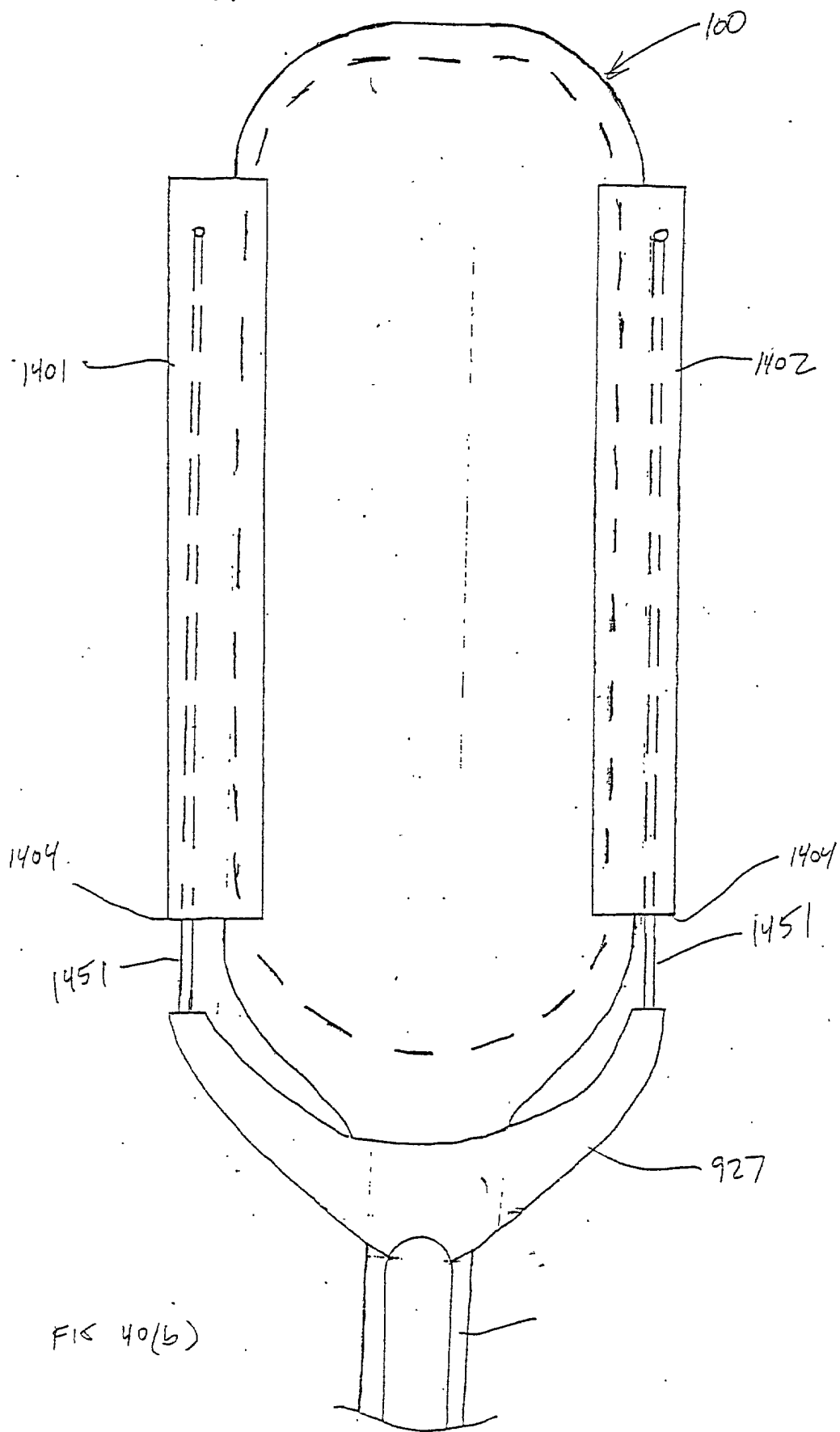
[illegible]

FIG 40(b)